

Compal confidential

Schematics Document

Mobile AMD S1G2 CPU with ATI
RX781(NB) & SB700(SB) core logic

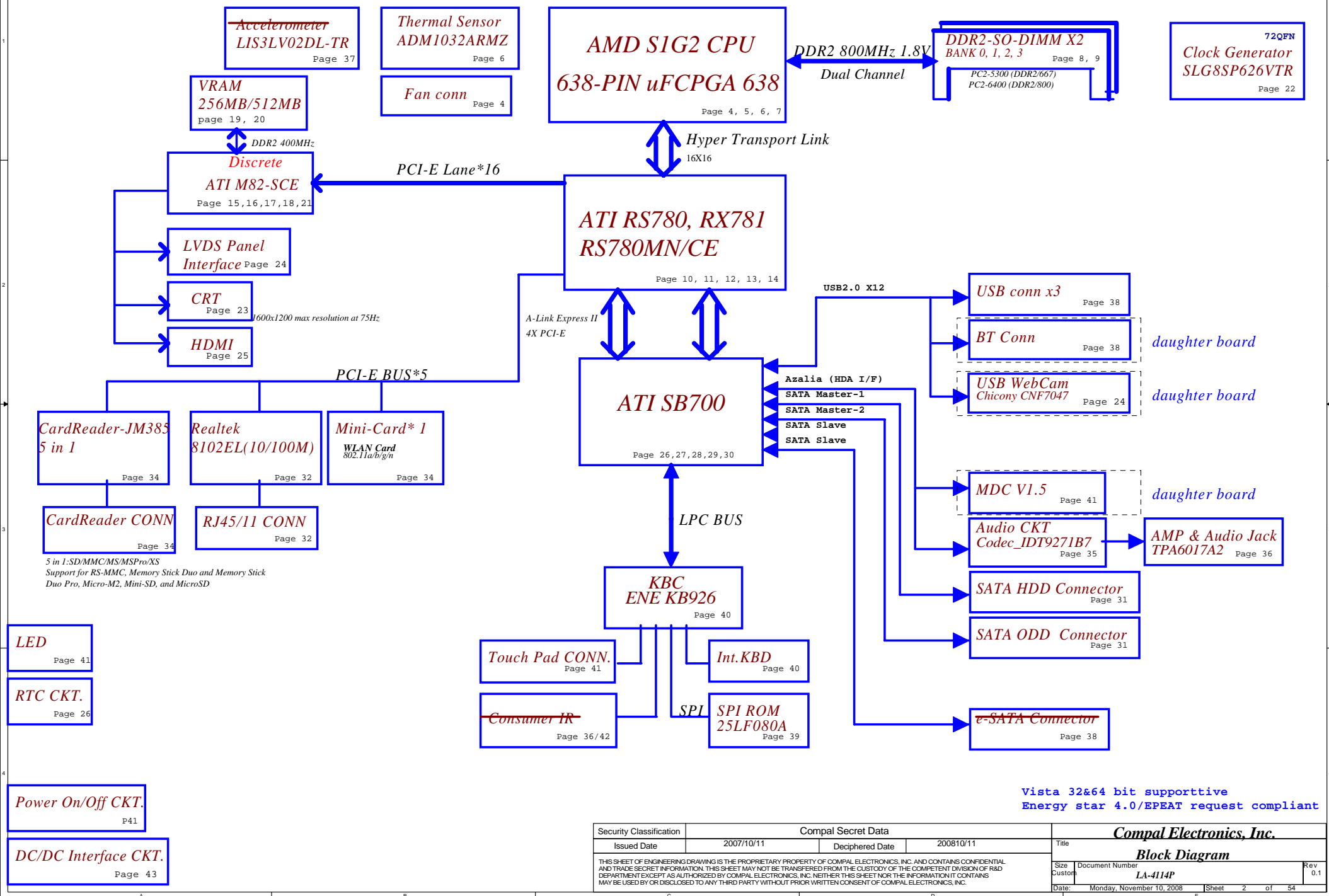
2008-11-07

REV:0.1



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OPP Rachman AMD 14" Discrete - LA-4114P



Vista 32&64 bit supporttve
Energy star 4.0/EPEAT request compliant

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Voltage Rails

○ MEANS ON X MEANS OFF

power plane State	+B +3VL +5VL	+5VALW +3VALW +1.2VALW	+1.8V +0.9V	+5VS +3VS +2.5VS +1.8VS +1.5VS +1.1VS +VGA_CORE +1.2V_HT +CPU_CORE_0 +CPU_CORE_1 +CPU_CORE_NB
S0	○	○	○	○
S1	○	○	○	○
S3	○	○	○	X
S5 S4/AC	○	○	X	X
S5 S4/ Battery only	○	X	X	X
S5 S4/AC & Battery don't exist	X	X	X	X

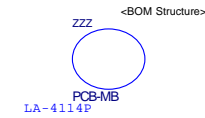
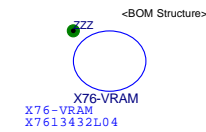
Symbol Note :

 : means Digital Ground

 : means Analog Ground

@ : means just reserve , no build

DEBUG@ : means just reserve for debug.



I2C / SMBUS ADDRESSING

DEVICE	HEX	ADDRESS
DDR SO-DIMM 0	A0	1 0 1 0 0 0 0 0
DDR SO-DIMM 1	A4	1 0 1 0 0 1 0 0
CLOCK GENERATOR (EXT.)	D2	1 1 0 1 0 0 1 0
ACCELEROMETER	3A	0 0 1 1 1 0 1 0

EC SM Bus1 address

EC SM Bus2 address

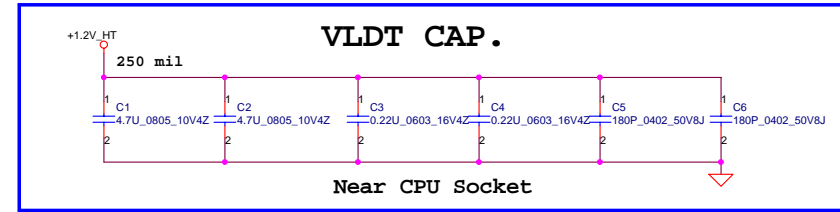
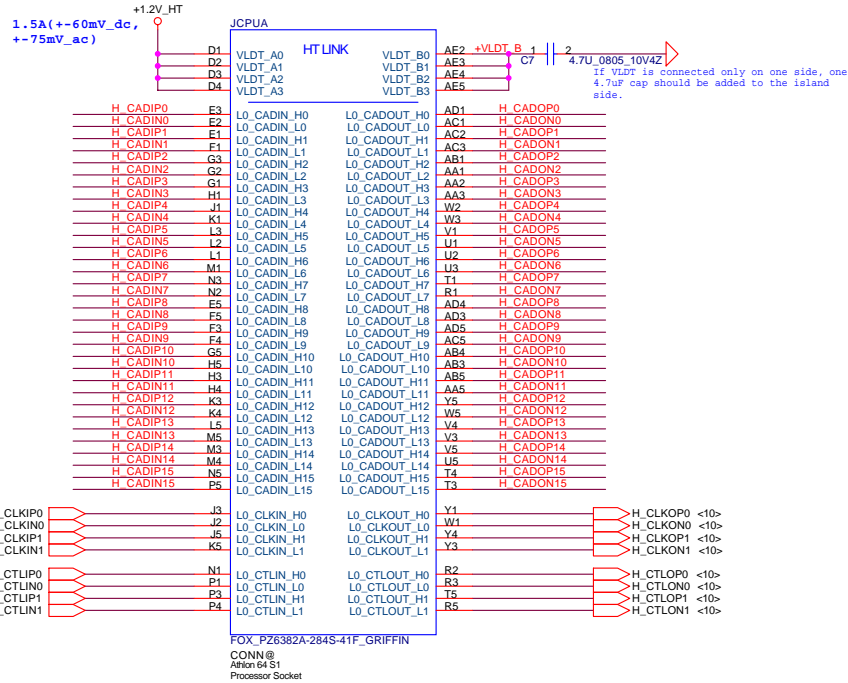
Device	HEX	Address	Device	HEX	Address
Smart Battery	16H	0001 011X b	ADH1032-2 CPU	9AH	1001 101X b
24C16	A0H	1010 000X b	ADH1032-1 VGA	98H	1001 100X b
CPU SIC interface	98H	1001 100X b			

SMBUS Control Table

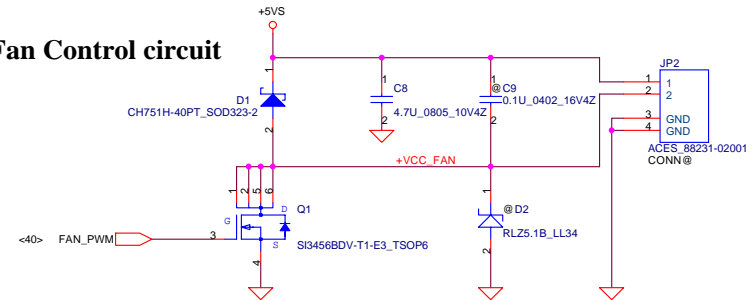
	SOURCE	THERMAL SENSOR VGA M82-SE ADM1032	BATT	SERIAL EEPROM	THERMAL SENSOR CPU & ADM1032	SODIMM I / II	CLK CHIP	WL MINI CARD Slot 1	LCD	HDMI	CRT	G-Sensor
SMB_EC_CK1	KB926	X	V	X	X	X	X	X	X	X	X	X
SMB_EC_DA1	KB926	V	X	X	V	X	X	X	X	X	X	X
SMB_EC_CK2	KB926	V	X	X	V	X	X	X	X	X	X	X
SMB_EC_DA2	KB926	V	X	X	V	X	X	X	X	X	X	X
SCL	VGA M82-SE	X	X	X	X	X	X	X	V	X	X	X
SDA	VGA M82-SE	X	X	X	X	X	X	X	V	X	X	X
DDC4CLK	VGA M82-SE	X	X	X	X	X	X	X	X	V	X	X
DDC4DATA	VGA M82-SE	X	X	X	X	X	X	X	X	V	X	X
DDC3CLK	VGA M82-SE	X	X	X	X	X	X	X	X	X	V	X
DDC3DATA	VGA M82-SE	X	X	X	X	X	X	X	X	X	V	X
SCL0	SB700	X	X	X	X	V	V	X	X	X	X	V
SDA0	SB700	X	X	X	X	V	V	X	X	X	X	V
SCL1	SB700	X	X	X	X	X	X	V	X	X	X	X
SDA1	SB700	X	X	X	X	X	X	V	X	X	X	X
SCL2	SB700	X	X	X	X	X	X	X	X	X	X	X
SDA2	SB700	X	X	X	X	X	X	X	X	X	X	X
SCL3	SB700	X	X	X	X	X	X	X	X	X	X	X
SDA3	SB700	X	X	X	X	X	X	X	X	X	X	X

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<10> H_CADIN[0..15] H_CADIN[0..15]
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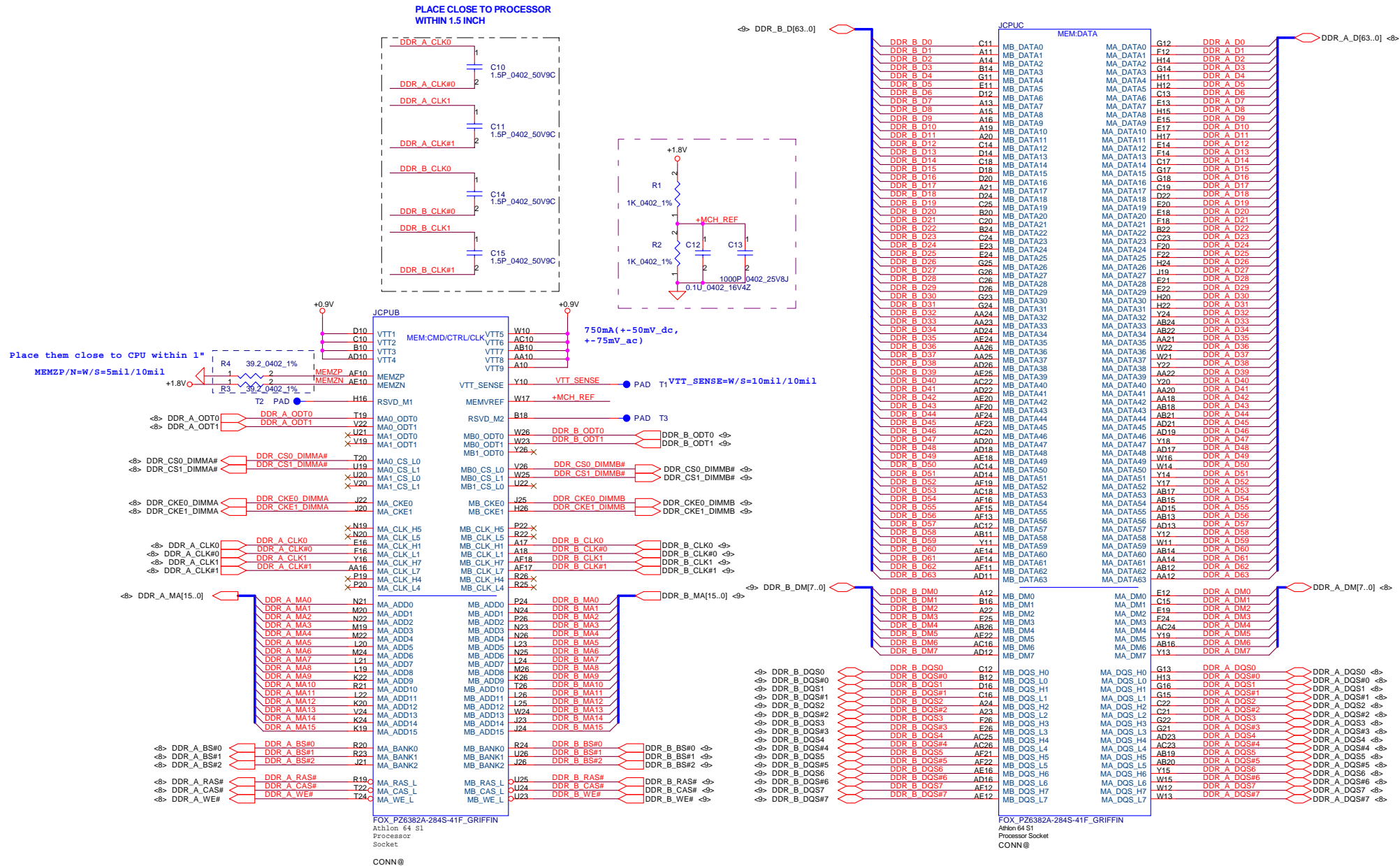


PWM Fan Control circuit

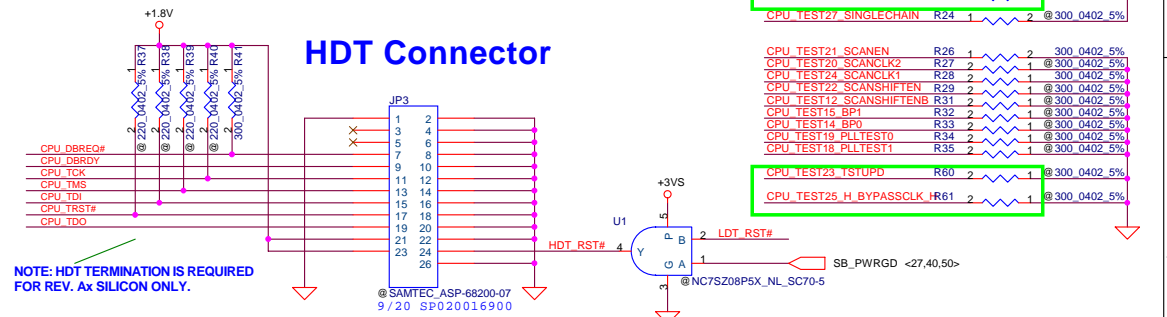
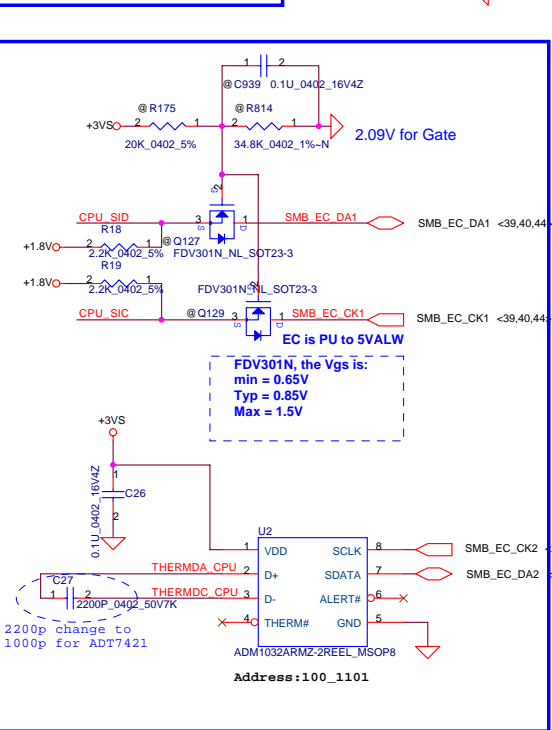
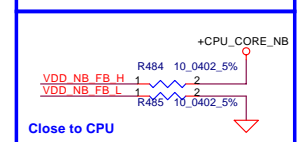


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								AMD CPU S1G2 HT I/F		
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Processor DDR2 Memory Interface

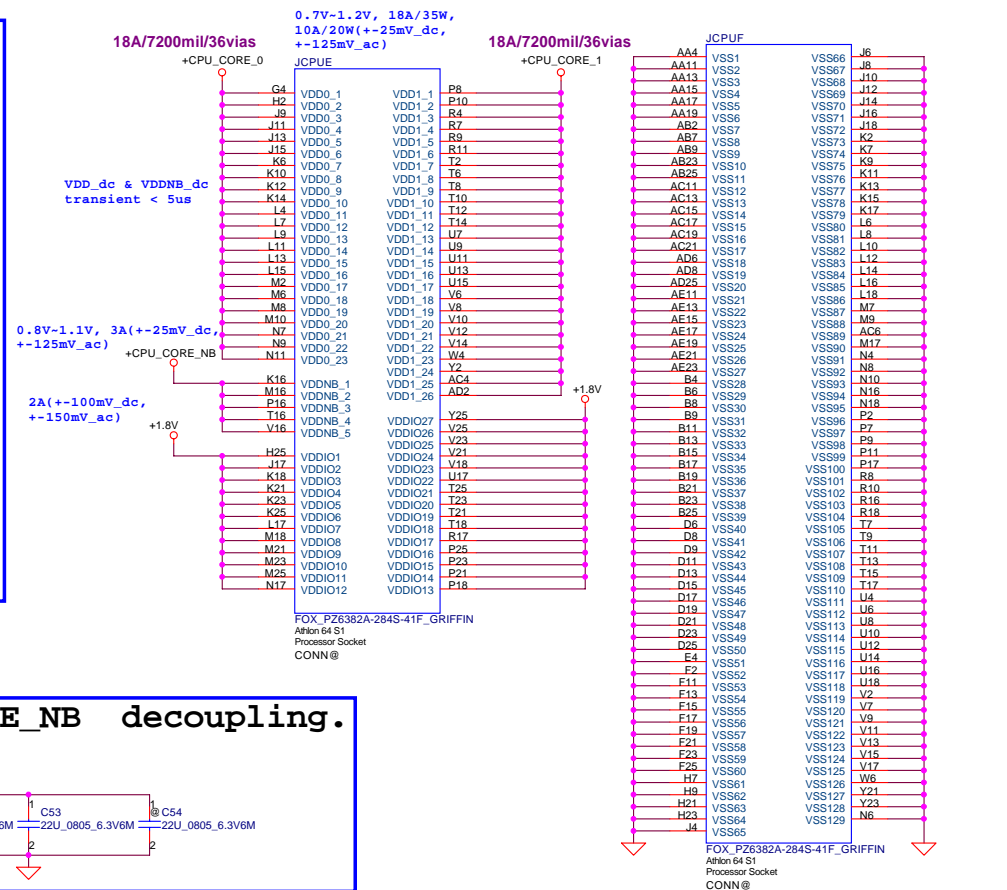
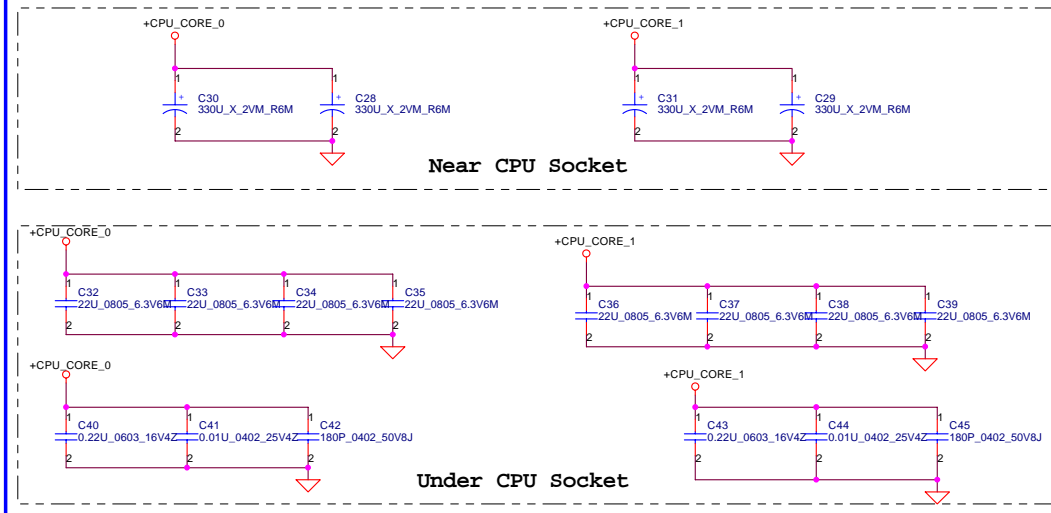


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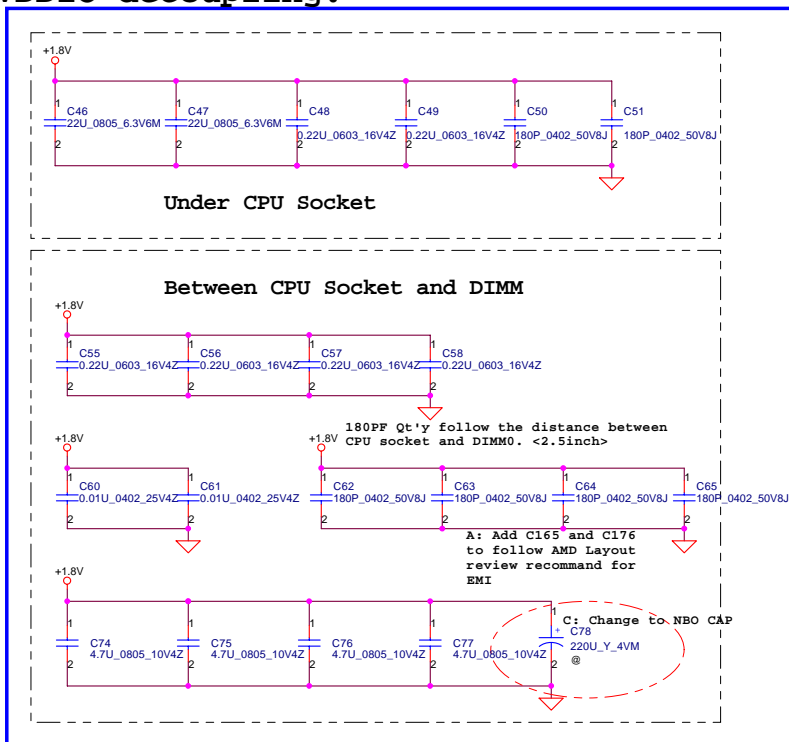


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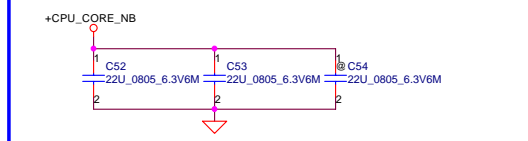
VDD(+CPU_CORE) decoupling.



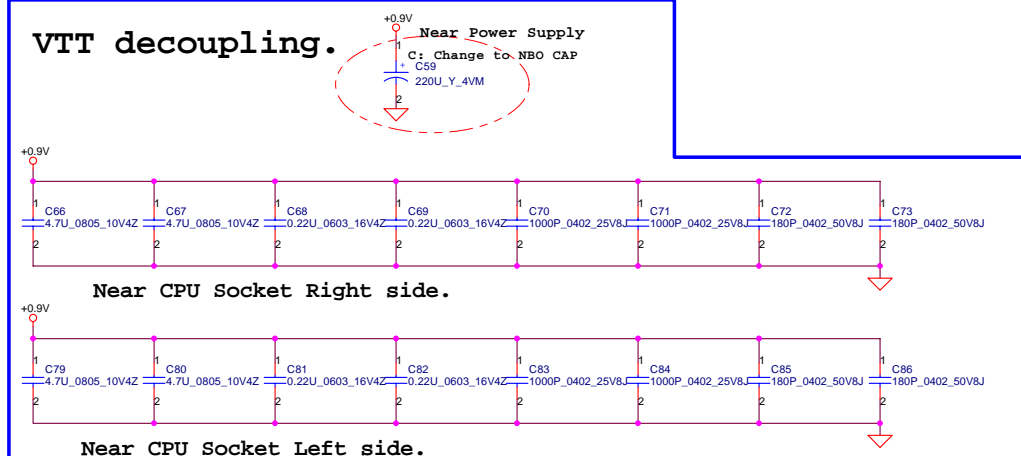
VDDIO decoupling.



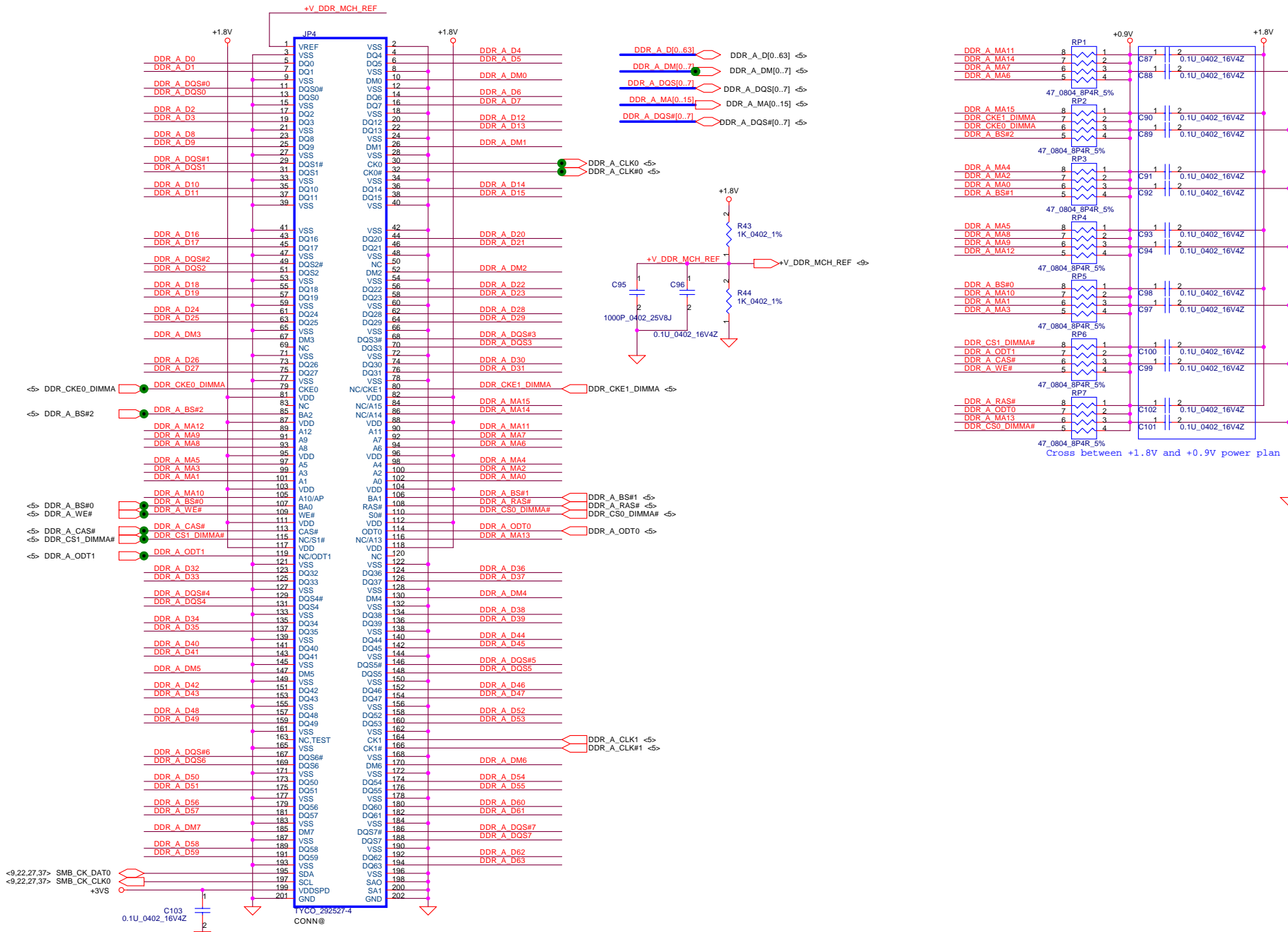
+CPU_CORE_NB decoupling.

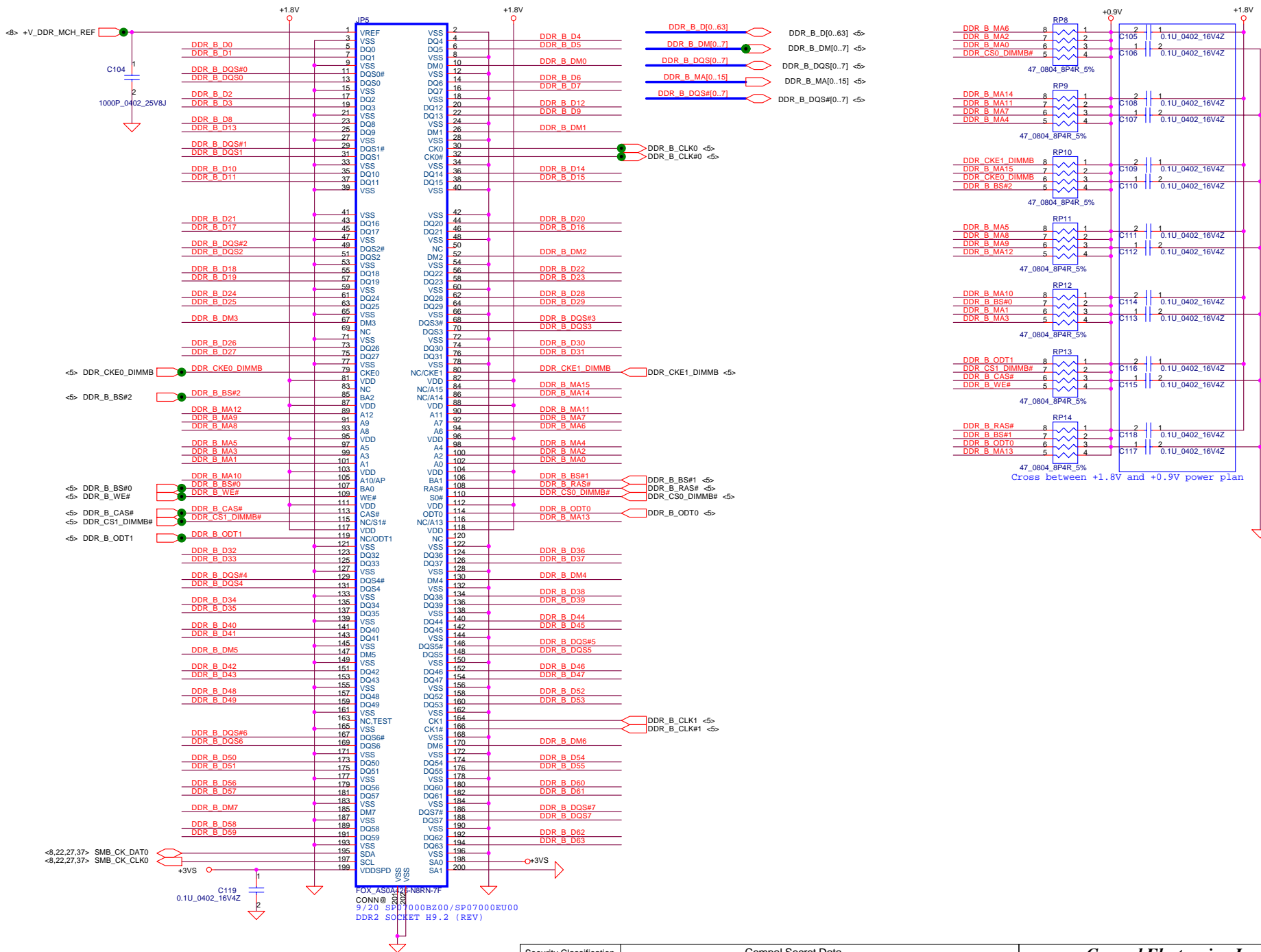


VTT decoupling.

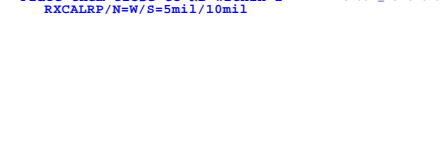
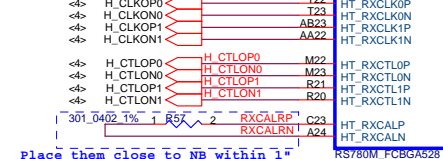
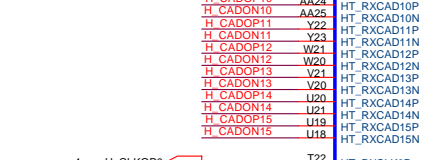
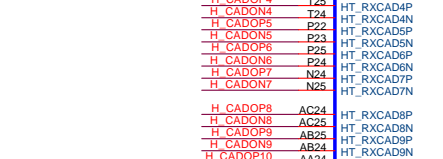
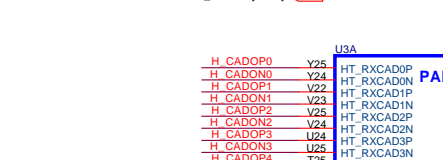
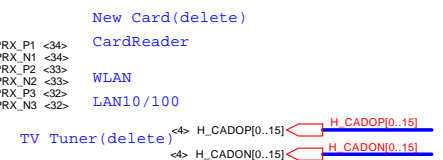
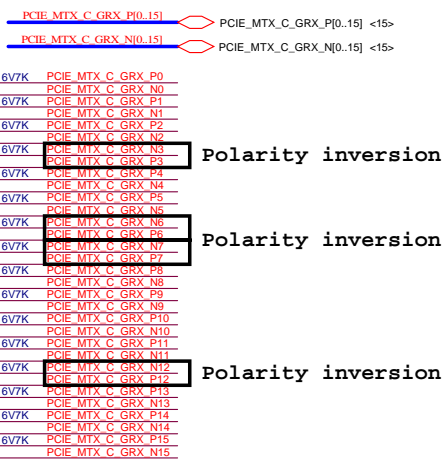


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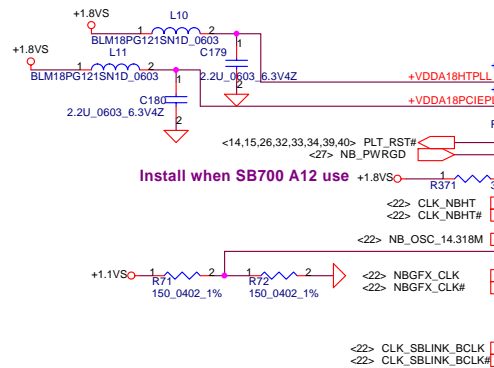




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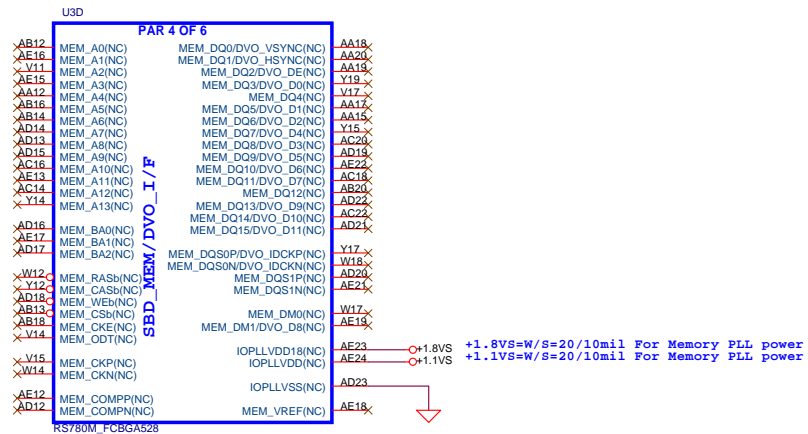


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Title			
RS780-HT/PCIE			
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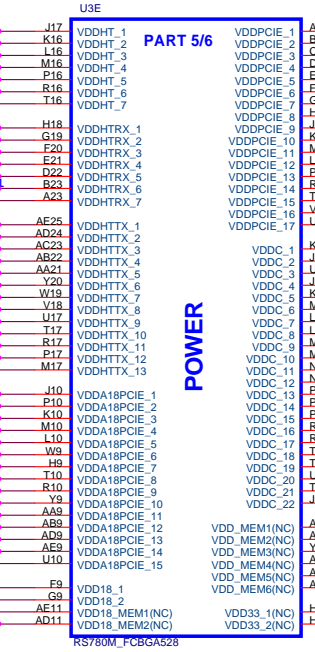
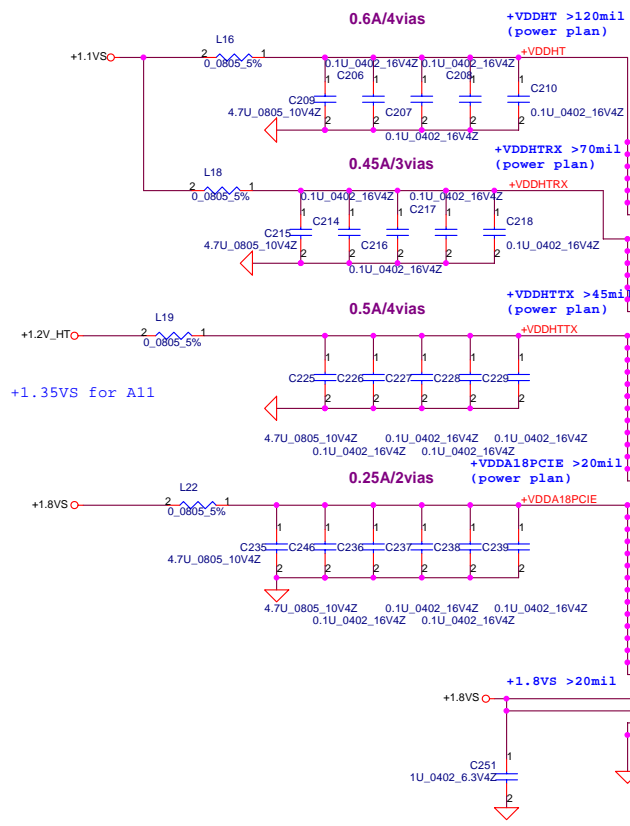


```
> SUS_STAT# <27>
> SUS_STAT_R# <14> Strap pin
                        NB temp to SB
```

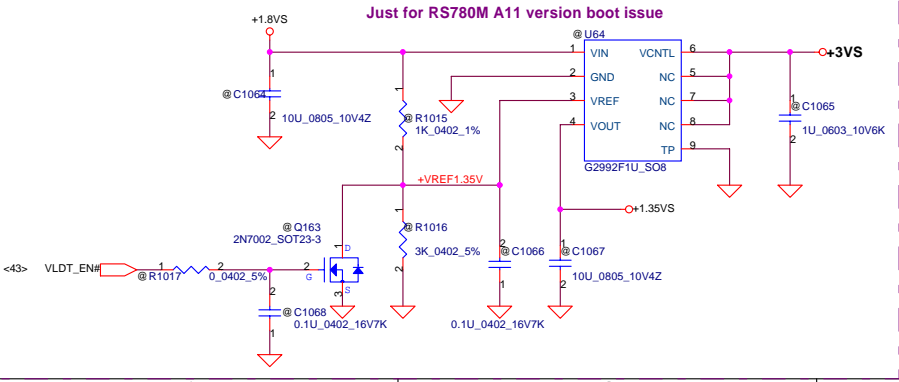
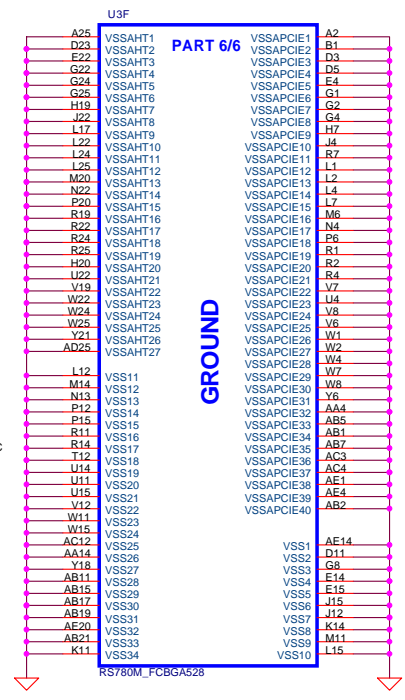
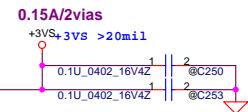
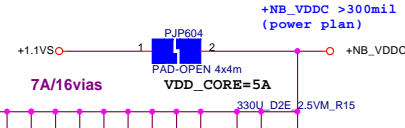
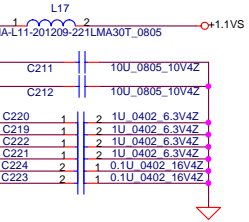
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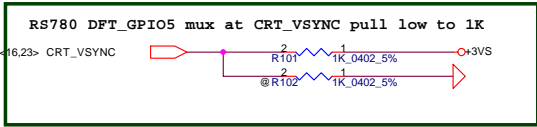


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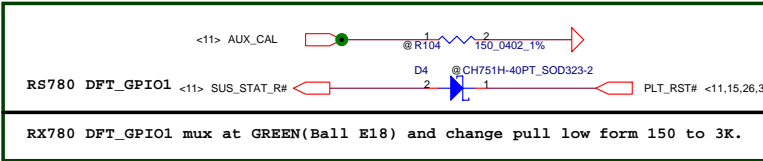
+VDDA11PCIE >300mil
(power plan)
0.7A/4vias
VDDA_12=2.5A





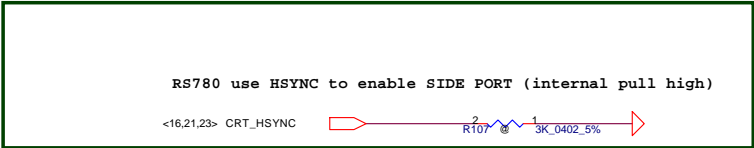
DFT_GPIO5:STRAP_DEBUG_BUS_GPIO_ENABLEb

Enables the Test Debug Bus using GPIO.
1 : Disable (RS740) Enable (RX780, RS780)
0 : Enable (Rs740) Disable (RX780, RS780)
PIN: RS740-->RS780_AUX_CAL; RX780-->NB_TV_C; RS780--> VSYNC#



DFT_GPIO1: LOAD_EEPROM_STRAPS

Selects Loading of STRAPS from EPROM
1 : Bypass the loading of EEPROM straps and use Hardware Default Values
0 : I2C Master can load strap values from EEPROM if connected, or use default values if not connected
RS740/RX780: DFT_GPIO1 RS780:SUS_STAT



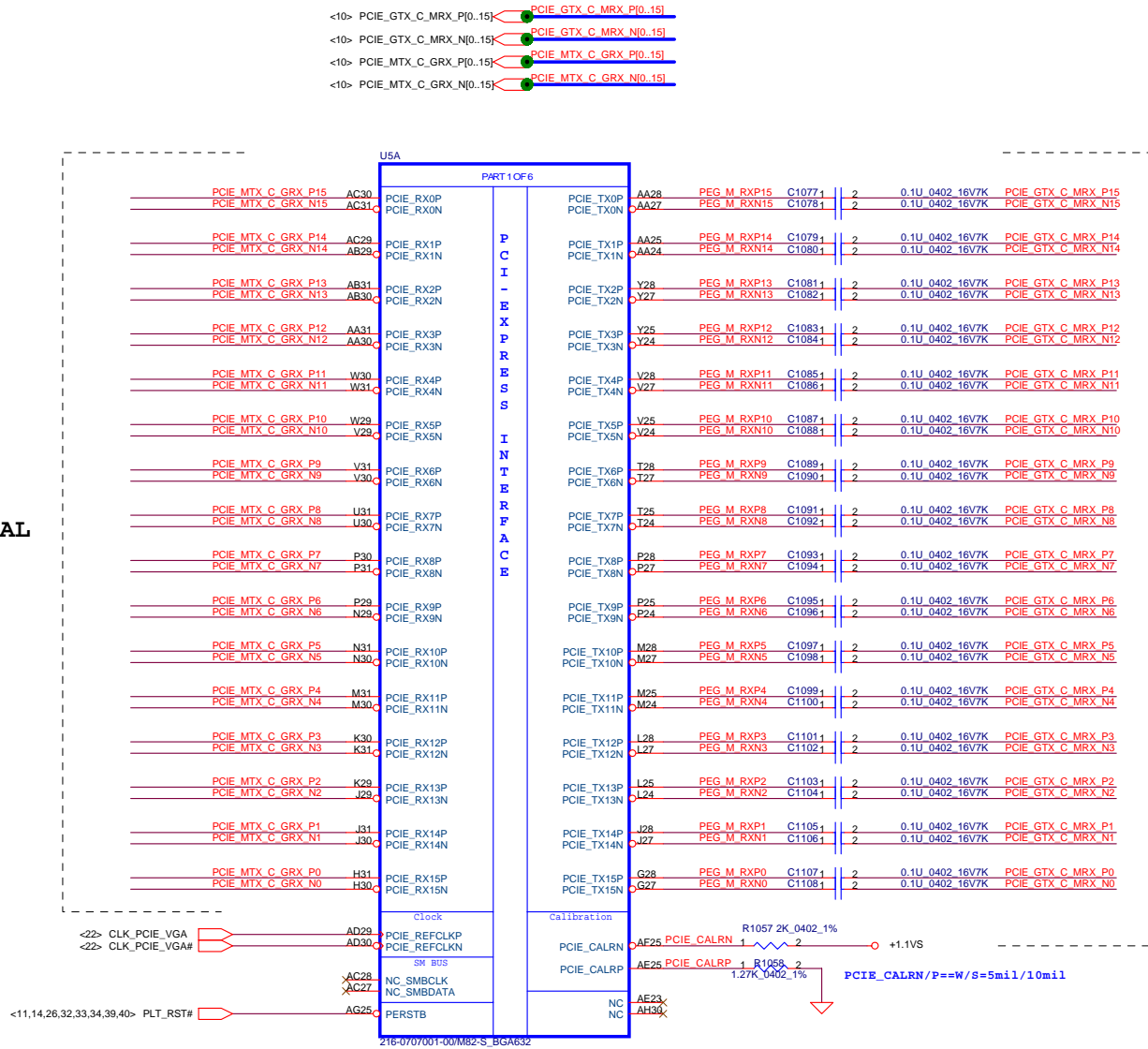
DFT_GPIO0:STRAP_DEBUG_BUS_PCIE_ENABLEb

RX780: Enables the Test Debug Bus using PCIE bus
1 : Disable (Can still be enabled using nbcfg register access)
0 : Enable
RS740/RS780: Enables Side port memory (RS780 use HSYNC#)
1. Disable (RS740/RS780)
0 : Enable (RS740/RS780)

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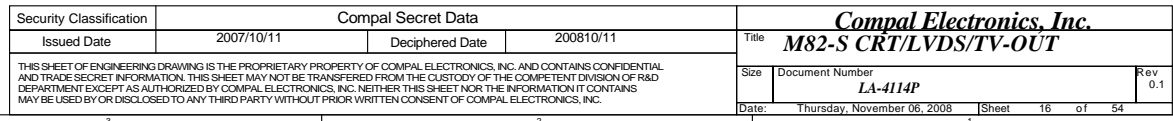
PCIE LANE REVERSAL

PCIE LANE REVERSAL



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+1.8VS 4 0 1U 0402 6 3V47



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MDA0 E29
MDA1 E30
MDA2 E31
MDA3 D31
MDA4 C29
MDA5 B29
MDA6 B30
MDA7 A29
MDA8 E28
MDA9 D26
MDA10 E25
MDA11 D25
MDA12 G23
MDA13 G21
MDA14 E21
MDA15 D21
MDA16 C28
MDA17 B28
MDA18 B27
MDA19 A27
MDA20 C25
MDA21 A25
MDA22 C24
MDA23 B24
MDA24 C23
MDA25 B23
MDA26 A23
MDA27 B22
MDA28 C20
MDA29 B20
MDA30 A20
MDA31 C19
MDA32 C8
MDA33 C7
MDA34 B7
MDA35 A7
MDA36 A5
MDA37 C4
MDA38 B4
MDA39 A3
MDA40 G9
MDA41 E9
MDA42 D9
MDA43 G7
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MDA46 G4
MDA47 F4
MDA48 B3
MDA49 B2
MDA50 C2
MDA51 C1
MDA52 E3
MDA53 F3
MDA54 F2
MDA55 E1
MDA56 G2
MDA57 G1
MDA58 J3
MDA59 J2
MDA60 K2
MDA61 L3
MDA62 L2
MDA63 L1

USC

Part 3 of 6

MEMORY INTERFACE

MA_0
MA_1
MA_2
MA_3
MA_4
MA_5
MA_6
MA_7
MA_8
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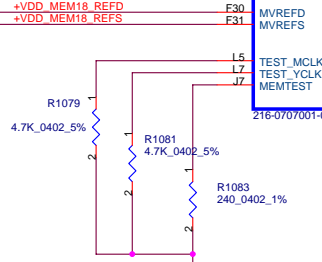
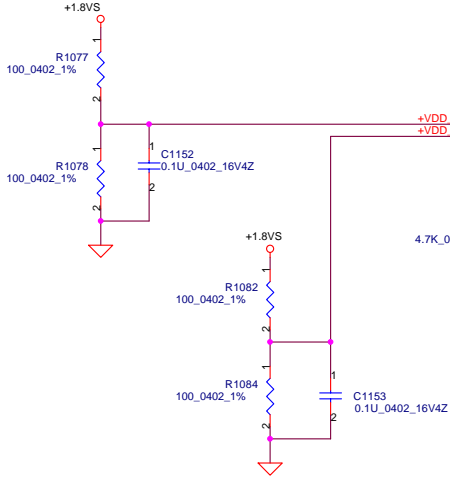
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BA[2..0] BA[2..0] <19,20>

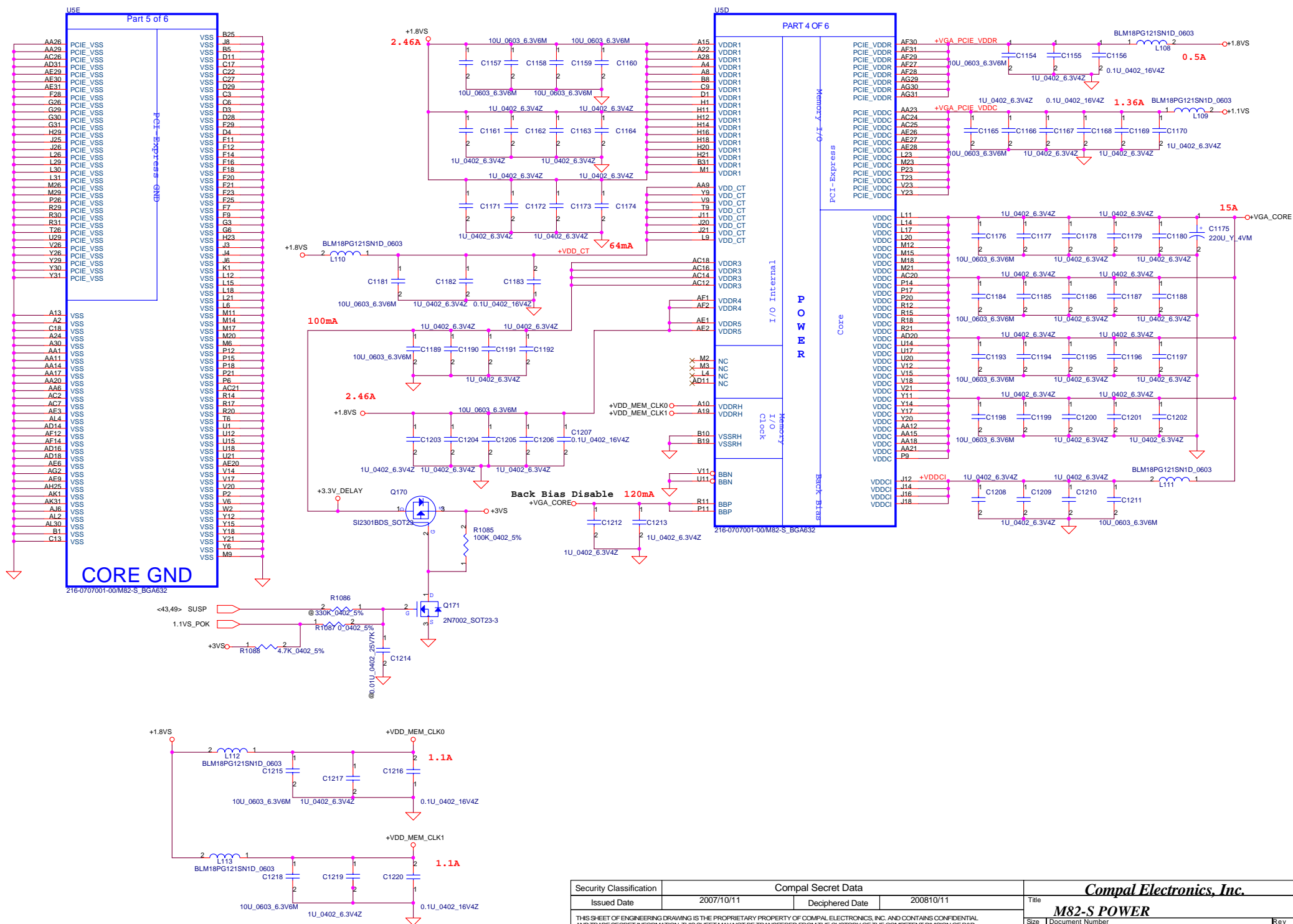
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DQMA#1
DQMA#2
DQMA#3
DQMA#4
DQMA#5
DQMA#6
DQMA#7

QSA#0
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QSA#2
QSA#3
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QSA#6
QSA#7

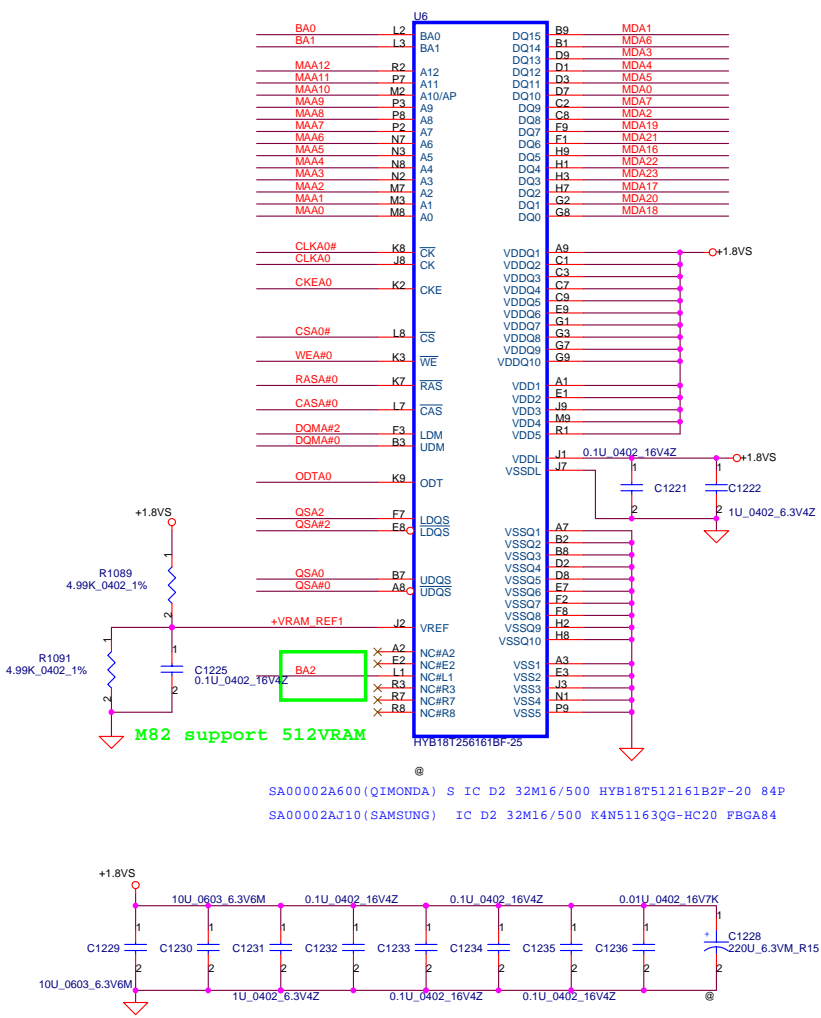
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ODTA1
CLKA0
CLKA1
CLKA0#
CLKA1#
RASA0
RASA1
CASA0
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CSA0#
CSA1#
CKEA0
CKEA1
WEA0
WEA1



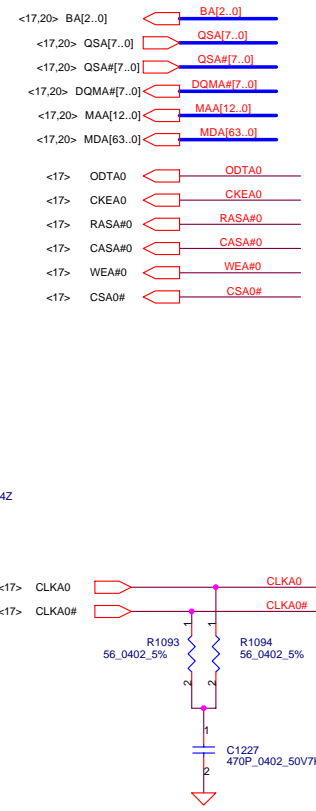
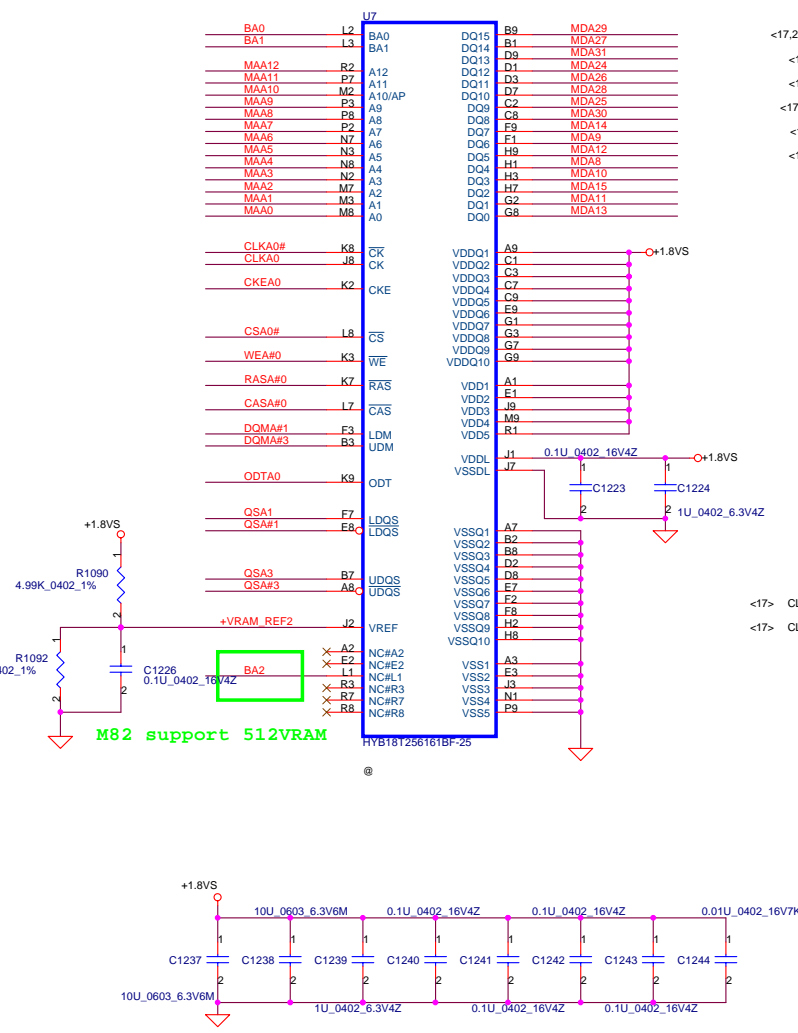
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		Size	Document Number						Rev
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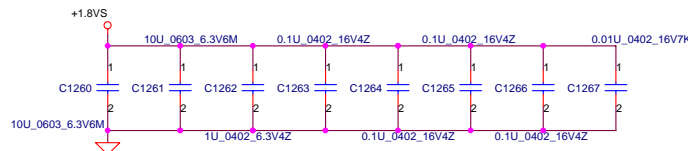
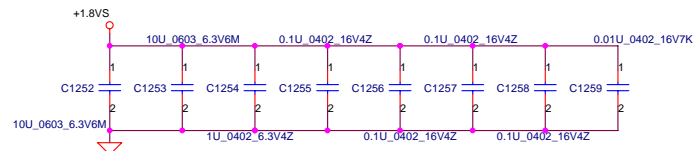
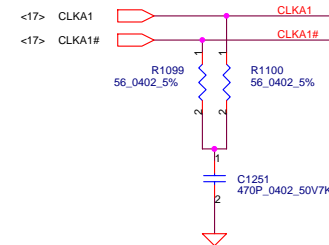
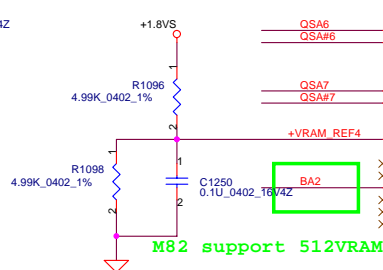
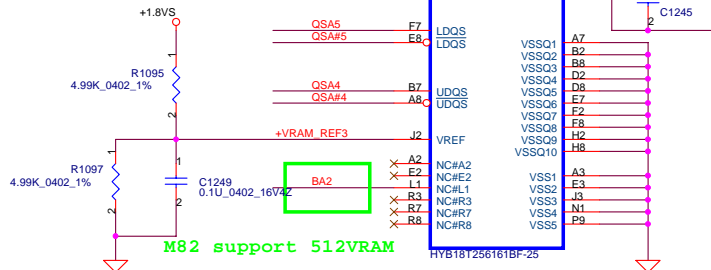
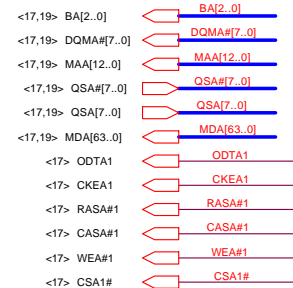
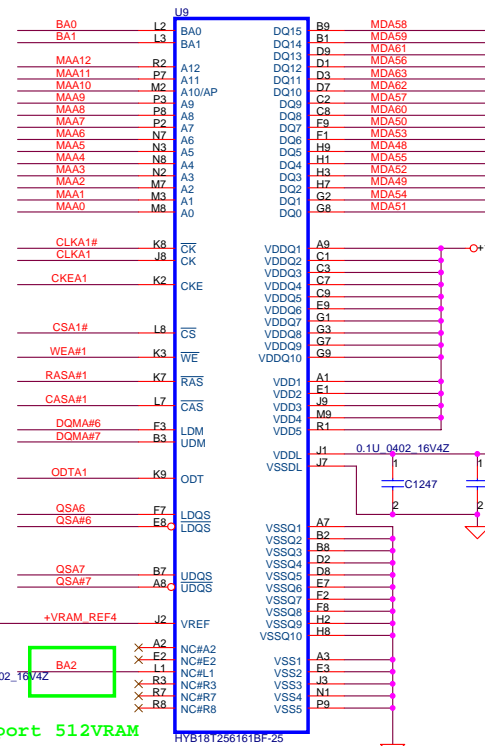
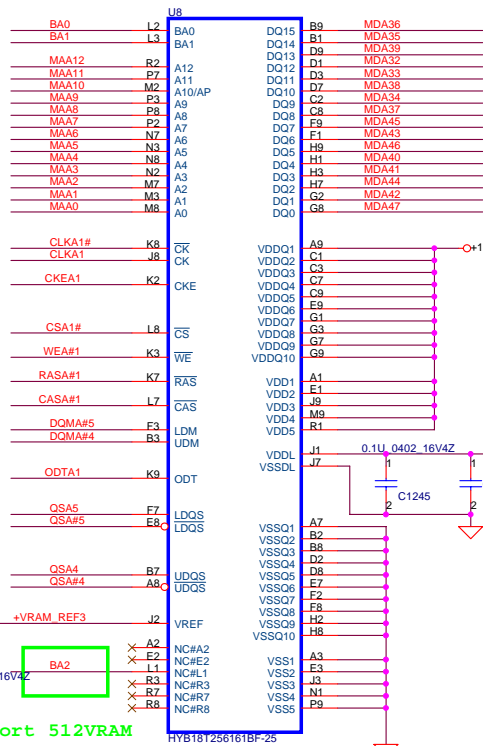


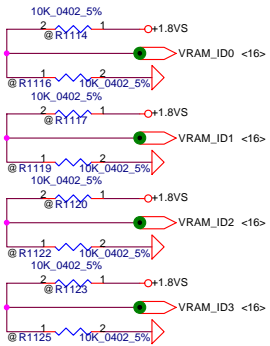
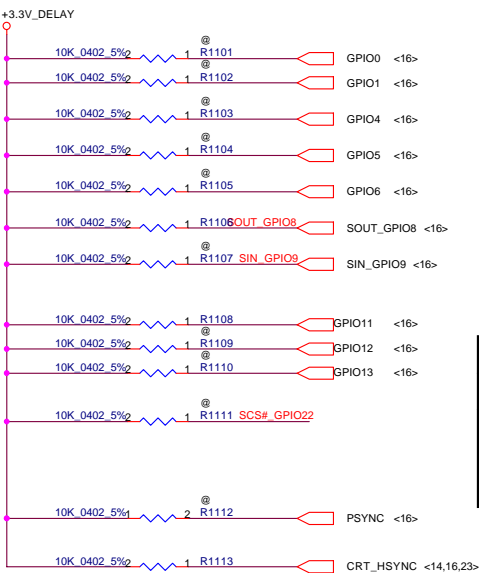
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						Size	Document Number				Rev 0.
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SA00002A600(QIMONDA) S IC D2 32M16/500 HYB18T512161B2F-20 84P
SA00002AJ10(SAMSUNG) IC D2 32M16/500 K4N51163QG-HC20 FBGA84







ATI RESERVED CONFIGURATION STRAPS									
ALLOW FOR PULLUP PADS FOR THESE STRAPS AND IF THESE GPIOs ARE USED, THEY MUST NOT CONFLICT DURING RESE									
GPIO2 GPIO3 GPIO5 GPIO6 DVALID H2SYNC V2SYNC									
PULLUP PADS ARE NOT REQUIRED FOR THESE STRAPS BUT IF THESE GPIOs ARE USED, THEY MUST NOT CONFLICT DURING RESET									
GENERICC GPIO21_BB_EN GPIO_28_TDO									

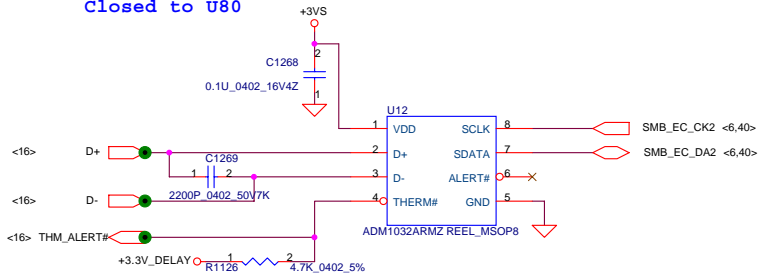
GPIO9 = 0 (BIOS_ROM_EN = 0)	
GPIO[13:11]	MEMORY SIZE
0 0 0	128MB
0 0 1	256MB
0 1 0	64MB
1 0 0	512MB

STRAPS	PIN	DESCRIPTION OF RECOMMENDED SETTING	RECOMMENDED MBX
TX_PWRS_ENB	GPIO0	PCIE FULL TX OUTPUT SWING	0
TX_DEEMPH_EN	GPIO1	PCIE TRANSMITTER DE-EMPHASIS ENABLES	0
BIF_DEBUG_ACCESS	GPIO4	DEBUG SIGNALS MUXED OUT	0
BIF_GEN2_EN_A	GPIO5	PCI-E 5.0GT/s or 2.5 GT/s select	0
DEBUG_I2C_ENABLE	GPIO6	Internal use only	0
BIF_AUDIO_EN	GPIO8	ENABLE HD AUDIO(M8X)	1
ROMIDCFG[3:0]	GPIO [9,13,12,11]	SERIAL ROM TYPE OR MEMORY APERTURE SIZE SELECT	0 1 0 1
BIOS_ROM_EN	GPIO_22_ROMCSB	DISABLE EXTERNAL BIOS ROM	0
BIF_VGA_DIS	PSYNC	VGA ENABLED==0 is enable	0
BIF_HDMI_EN	HSYNC	HDMI ENABLE	1

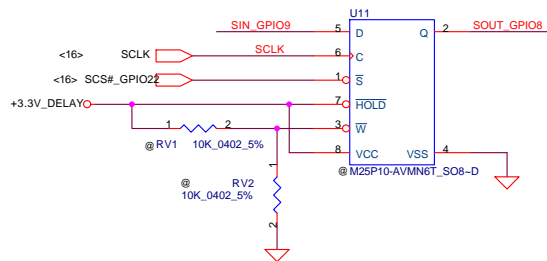
STRAPS	PIN	GPU	Project	VRAM size	Vendor Part Number#	Compal Part Number#	VRAM_ID 3,2,1,0
VRAM_ID[3:0]	DVPDATA (23,22,21,20)	M82M-XT	Rachman 1.2	512M(x4)	Samsung 64Mx16 1.8V	SA00002MD00	0 0 0 0
			Rachman 1.2	256M(X4)	Samsung 32Mx16 1.8V	SA00002AJ10	0 0 0 1
				512M(x4)	Hynix 64Mx16 1.8V		0 0 1 0
			Rachman 1.1	256M(X4)	Hynix 32Mx16 1.8V	SA00002DL00	0 0 1 1
			Rachman 1.1	256M(X4)	Qimonda 32Mx16 1.8V	SA00002A600	0 1 0 0
			Rachman 1.2	512M(x4)	Qimonda 64Mx16 1.8V	SA00002MF00	0 1 0 1

VGA Thermal Sensor ADM1032ARMZ

Closed to U80

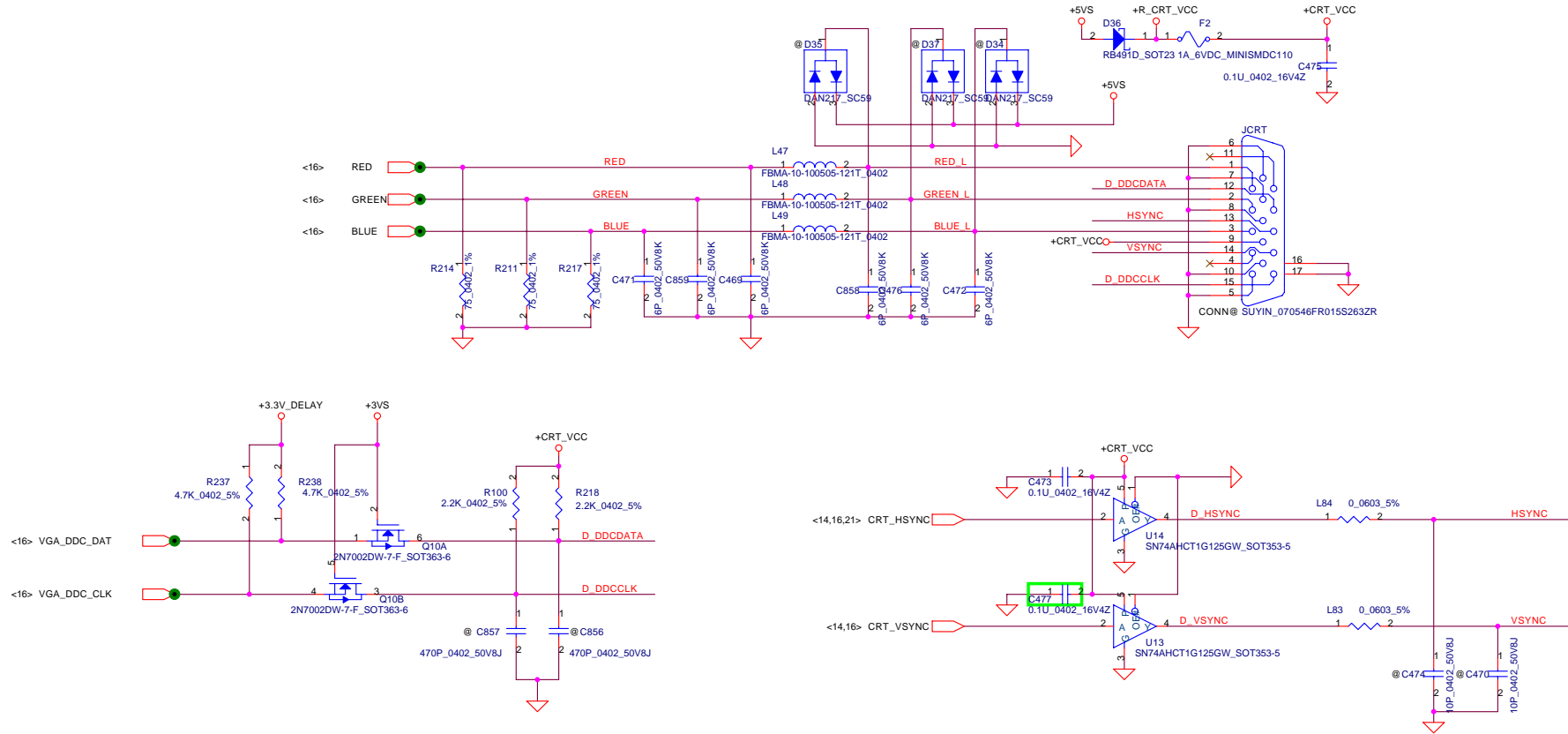


FLASH ROM



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Size	Document Number	LA-4114P		Rev 0.1	
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CRT CONNECTOR

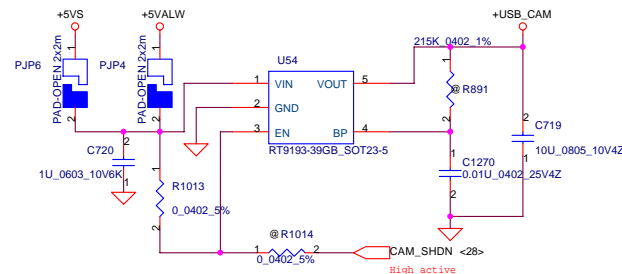
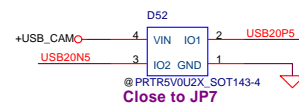
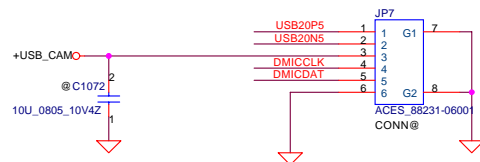


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				0.1	
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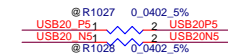
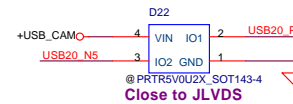
Compal Electronics, Inc.

CRT Connector

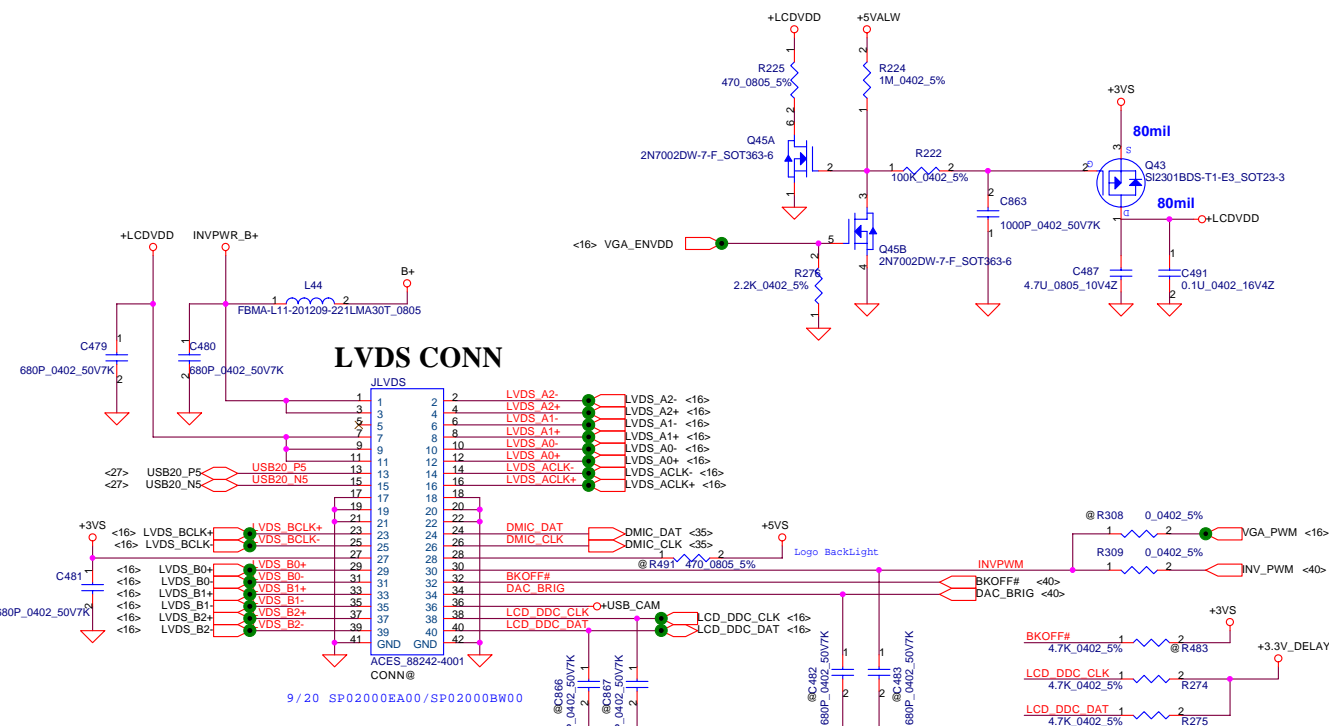
LA-4114P

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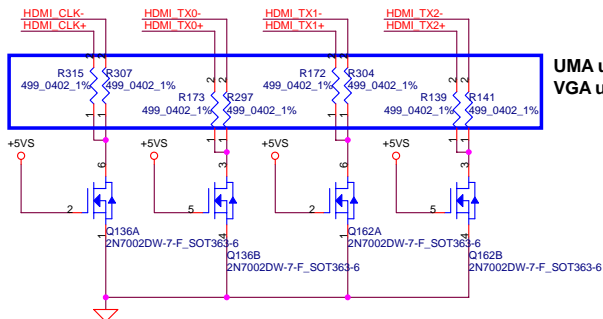
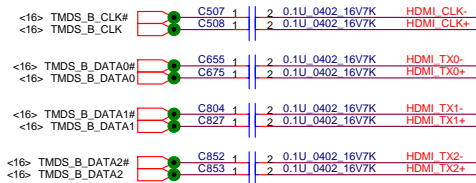
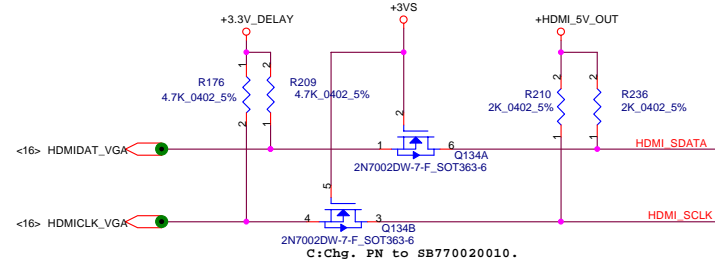
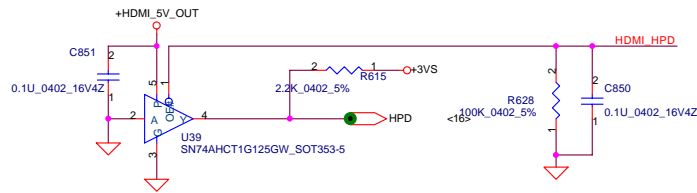
USB_VCCA is +3.9V, R892:100K; R891:215KKohm
G916 Vref=1.25V



Close to JLVDS

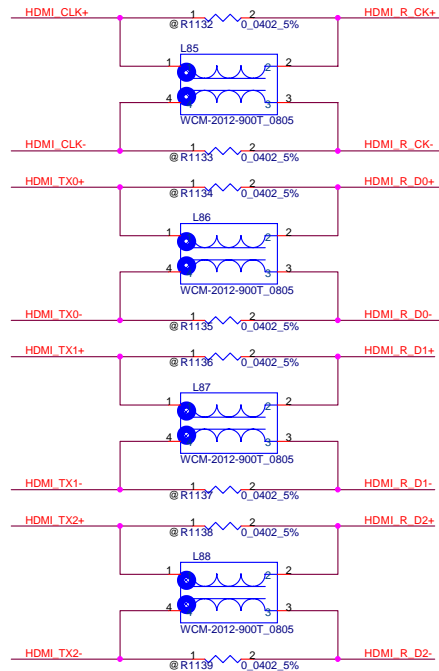


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				Size	Document Number	Rev		
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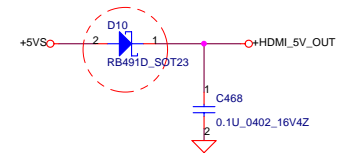


UMA use 750 ohm
VGA use 499 ohm

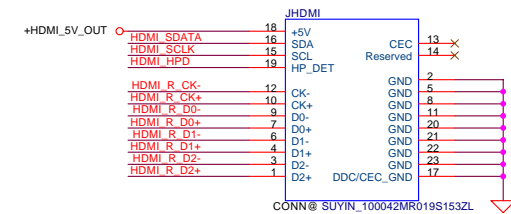
COMMON MODE CHOCK is SM070000K00 KING_WCM-2012-900T_4P



MP:Update D10 to meet HDMI.

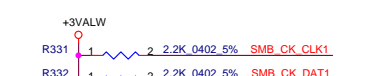
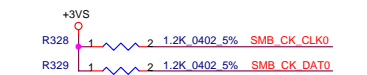
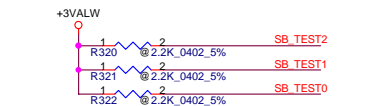
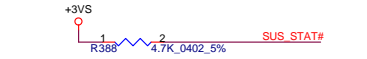
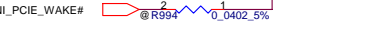
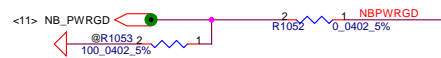


HDMI Connector

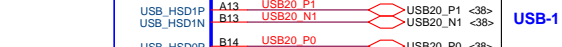
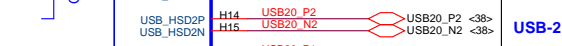
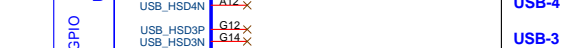
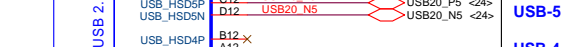
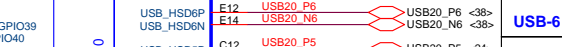
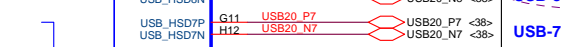
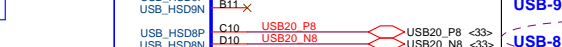
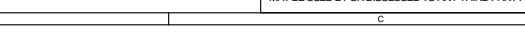
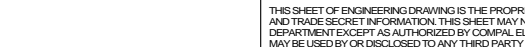
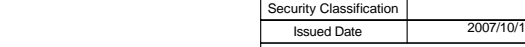
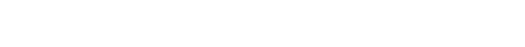
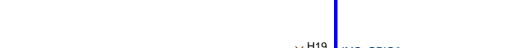
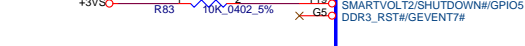
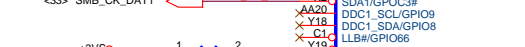
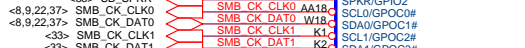
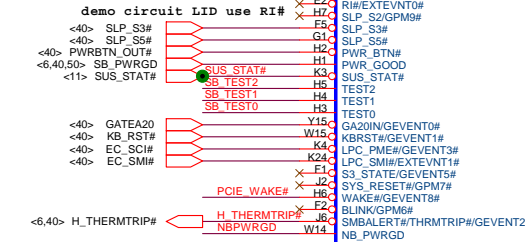
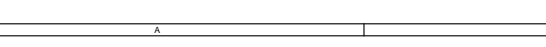
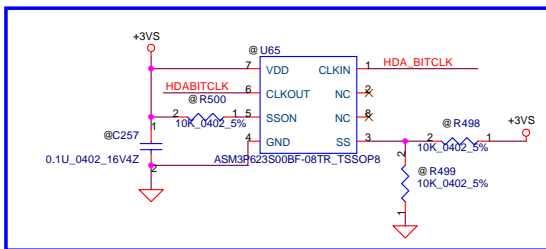


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					Size	Document Number	Rev	0.1	
					Custom	LA-4114P			
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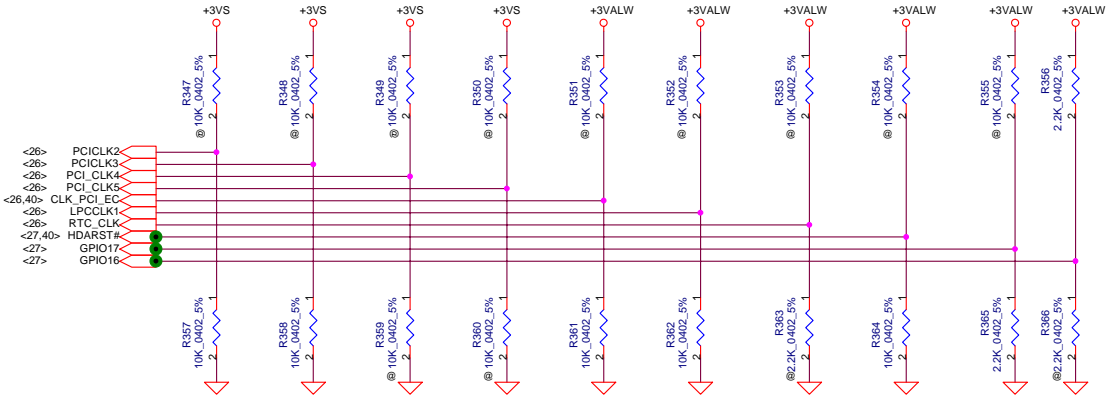
For EMI request.



REQUIRED STRAPS

NOTE: SB700 HAS INTERNAL 15K PULL UP RESISTOR FOR RTC_CLK

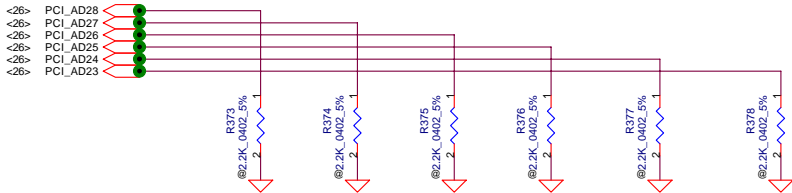
	PCI_CLK2	PCI_CLK3	PCI_CLK4	PCI_CLK5	AZ_RST_CD#	LPC_CLK1	RTC_CLK	LPC_CLK0	GP17	GP16
PULL HIGH	BOOTFAIL TIMER ENABLED	USE DEBUG STRAPS	RESERVED	RESERVED	ENABLE PCI MEM BOOT	CLKGEN ENABLED	INTERNAL RTC DEFAULT	EC ENABLED	Internal pull up H,H = Reserved H,L = SPI ROM	L,H = LPC ROM (Default) L,L = FWH ROM
PULL LOW	BOOTFAIL TIMER DISABLED DEFAULT	IGNORE DEBUG STRAPS DEFAULT			DISABLE PCI MEM BOOT DEFAULT	CLKGEN DISABLED DEFAULT	EXT. RTC (PD on X1, apply 32KHz to RTC_CLK)	EC DISABLED DEFAULT		



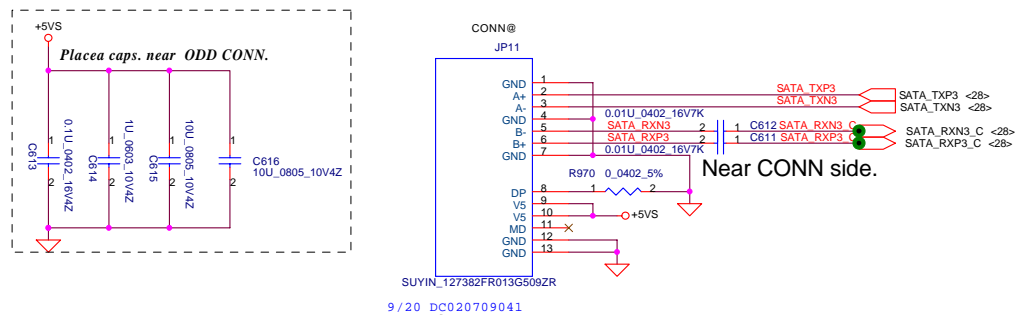
DEBUG STRAPS

SB700 HAS 15K INTERNAL PU FOR PCI_AD[28:23]

	PCI_AD28	PCI_AD27	PCI_AD26	PCI_AD25	PCI_AD24	PCI_AD23
PULL HIGH	USE LONG RESET DEFAULT	USE PCI PLL DEFAULT	USE ACPI BCLK DEFAULT	USE IDE PLL DEFAULT	USE DEFAULT PCIE STRAPS DEFAULT	RESERVED
PULL LOW	USE SHORT RESET	BYPASS PCI PLL	BYPASS ACPI BCLK	BYPASS IDE PLL	USE EEPROM PCIE STRAPS	

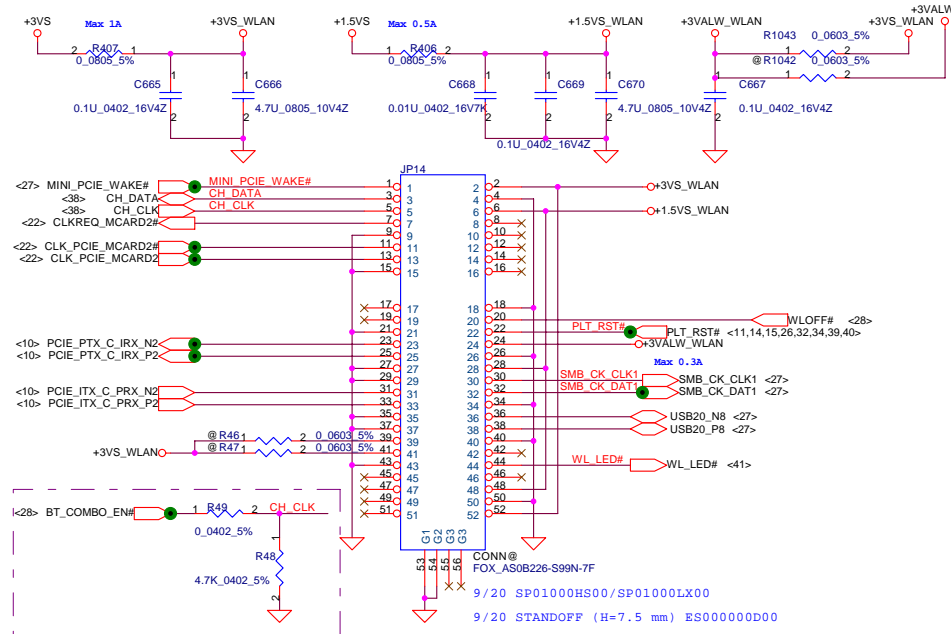


Multi-Bay Connector-option(deltet)

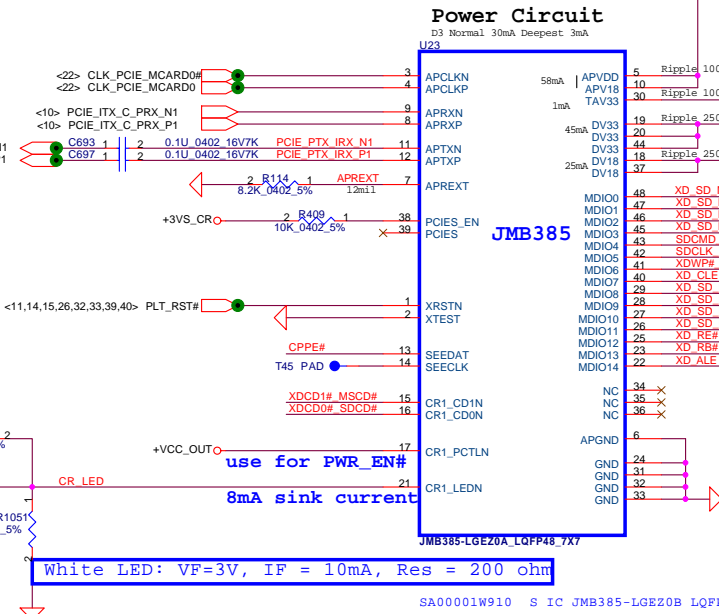
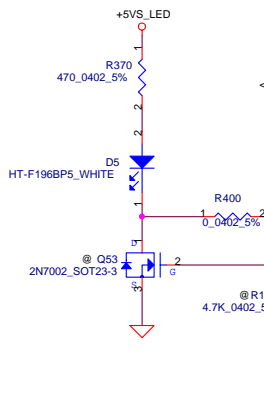
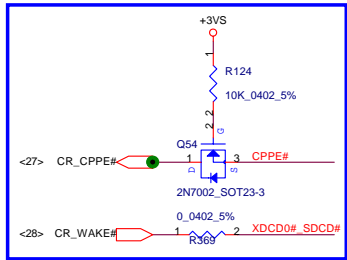
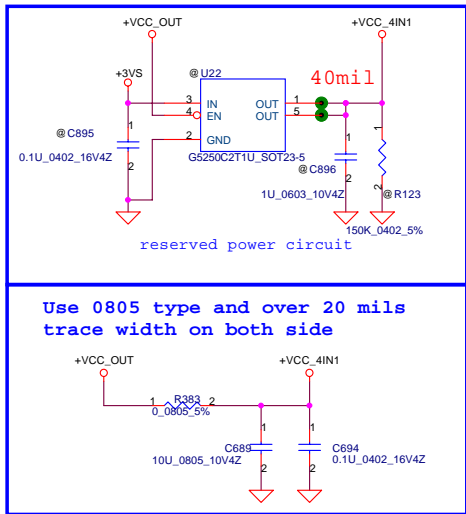


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Issued Date	2007/10/11	Deciphered Date	2008/10/11		
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				Size	Rev
				Custom	0.1
Document Number LA-4114P				Date: Thursday, November 06, 2008 Sheet 31 of 54	

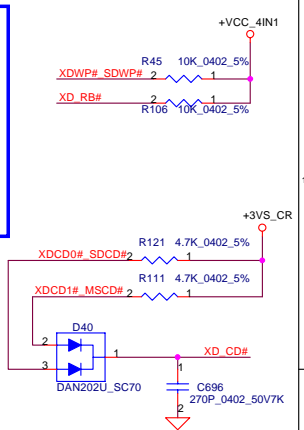
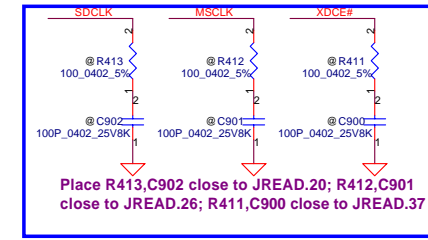
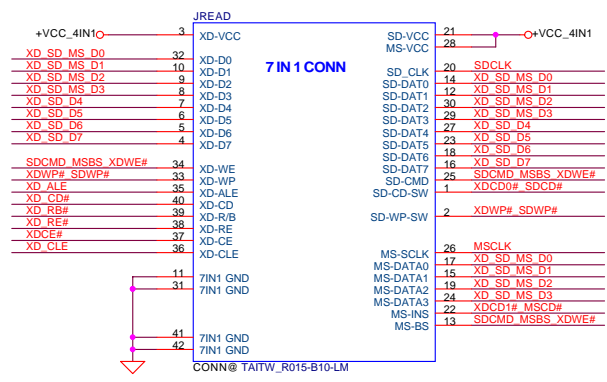
Mini Card Slot 1---WLAN



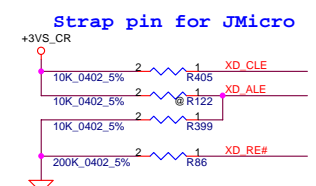
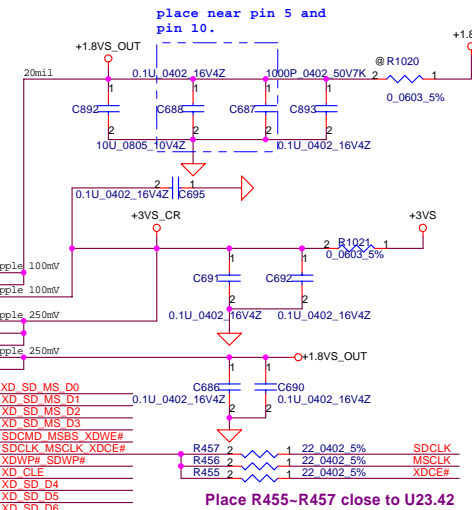
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				Date:	Thursday, November 06, 2008
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Card Reader Connector



Power Circuit

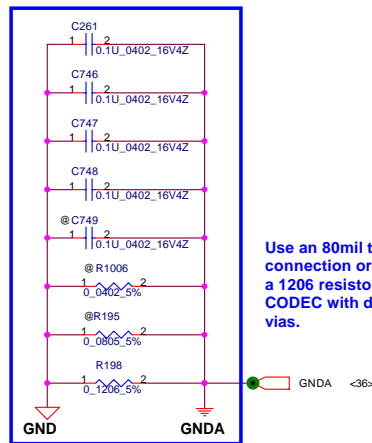
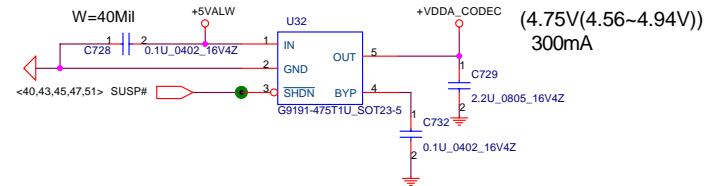


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Issued Date	2007/10/11	Deciphered Date	2008/10/11	Document Number
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Date: Thursday, November 06, 2008				Sheet 34 of 54

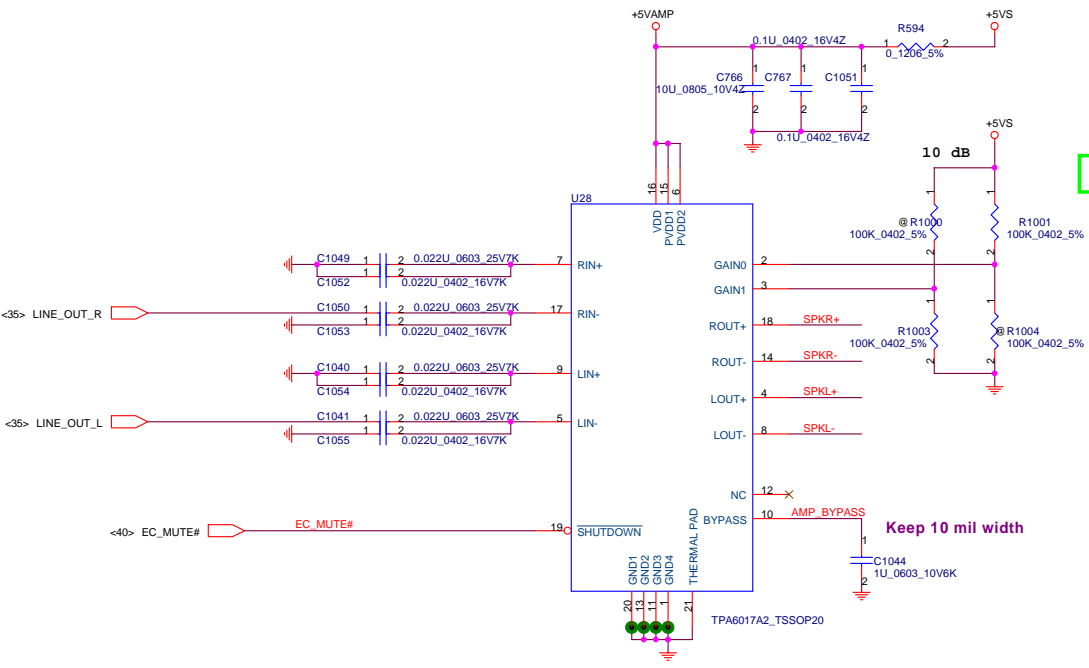
Compal Electronics, Inc.

PCI-E I/F Card Reader-JM385

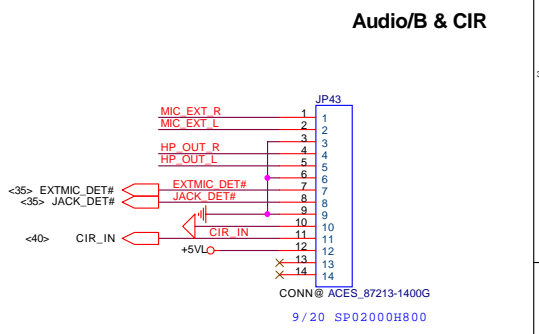
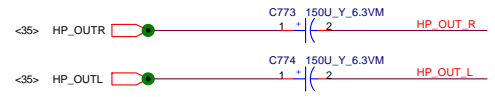
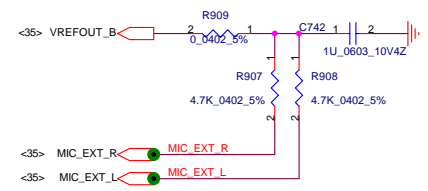
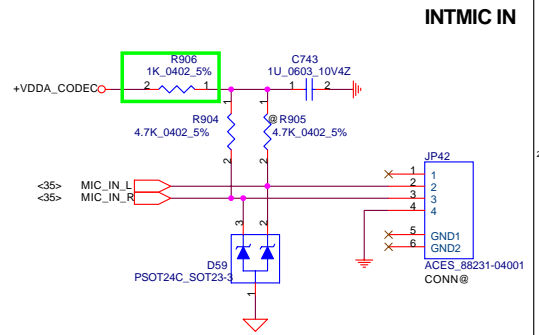
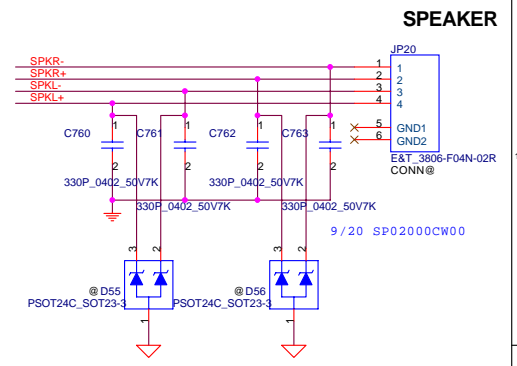
LA-4114P



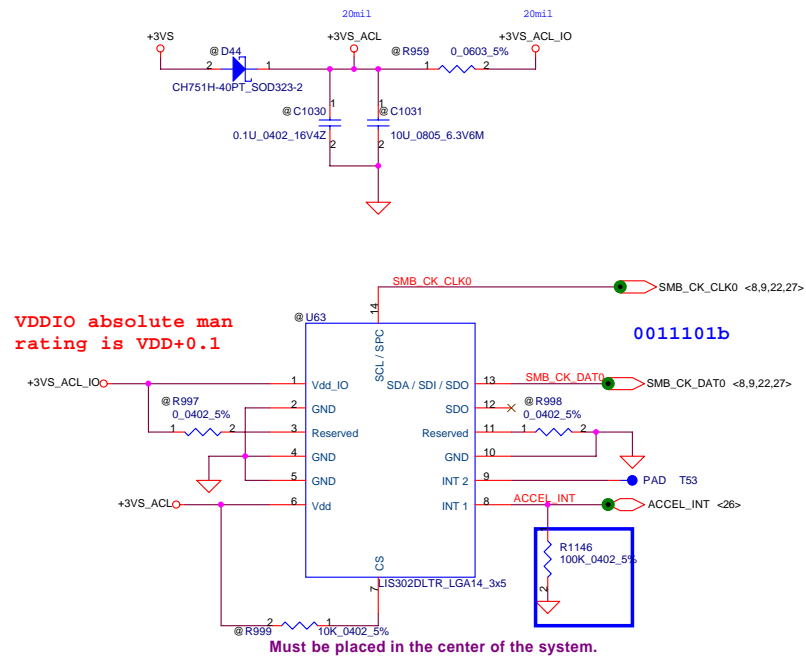
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Date:				Thursday, November 06, 2008		Sheet	35 of 54



GAIN0	GAIN1	Av(inv)
0	0	6dB
0	1	10dB
1	0	15.6dB
1	1	21.6dB

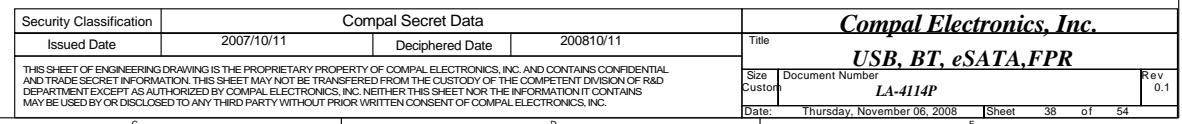


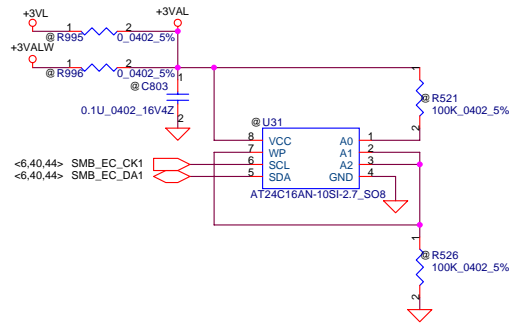
ACCELEROMETER



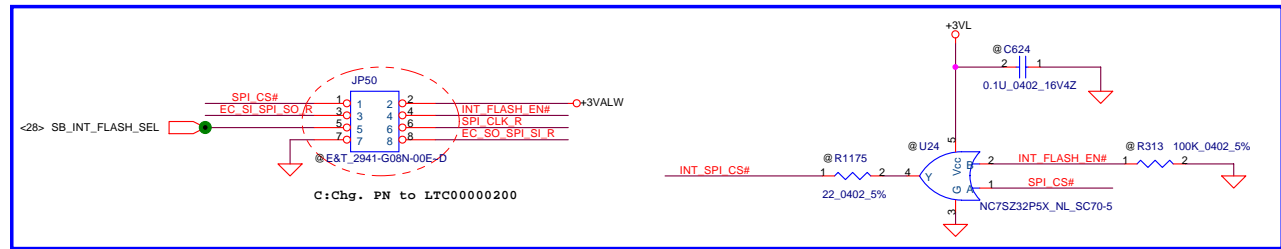
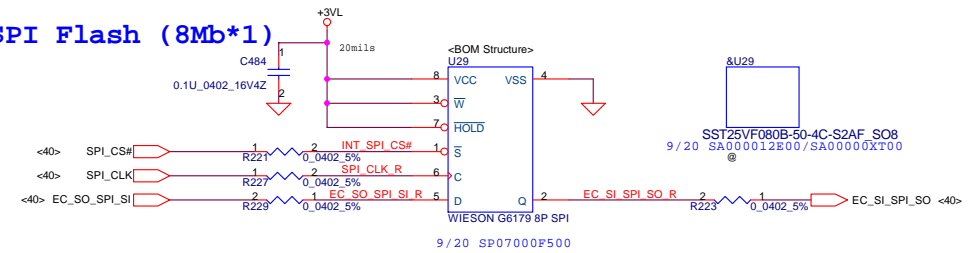
Security Classification		Compal Secret Data		Title	
Issued Date	2007/10/11	Deciphered Date	200810/11	Accelerometer	
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Right side USB 0&1 Board Conn

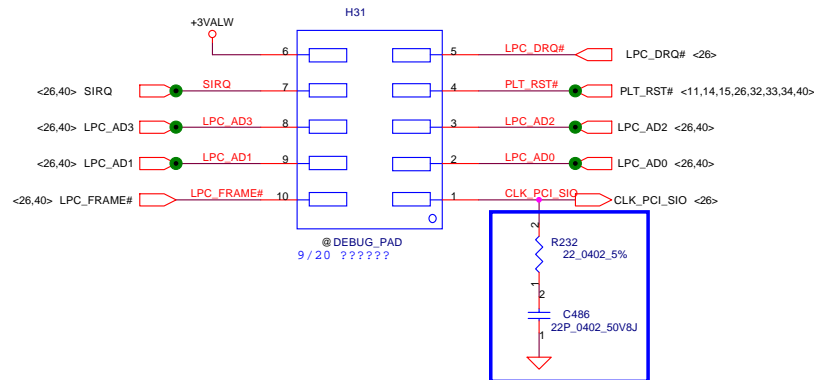




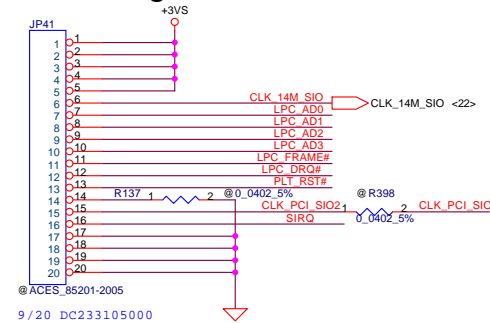
SPI Flash (8Mb*1)



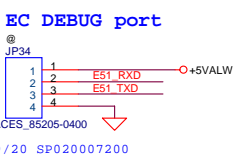
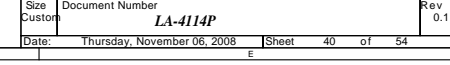
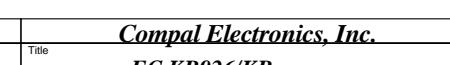
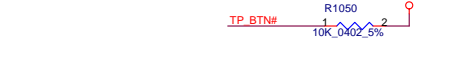
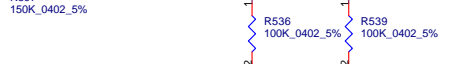
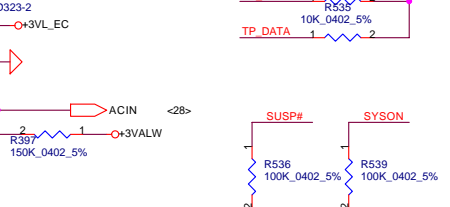
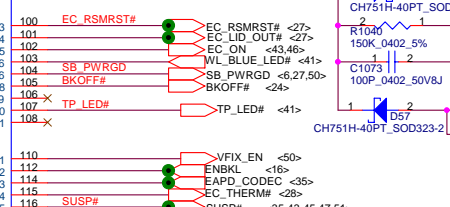
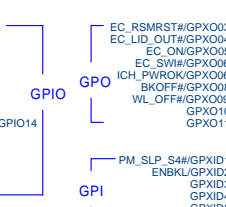
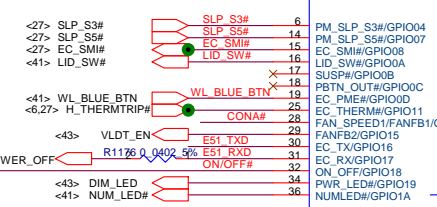
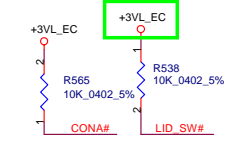
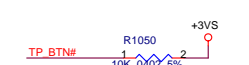
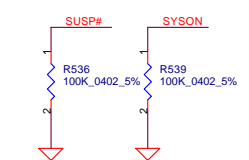
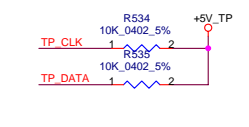
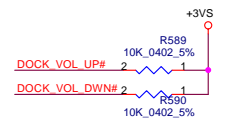
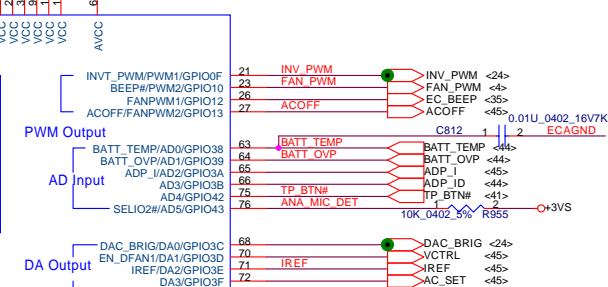
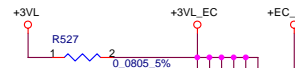
LPC Debug Port



LPC Debug Port



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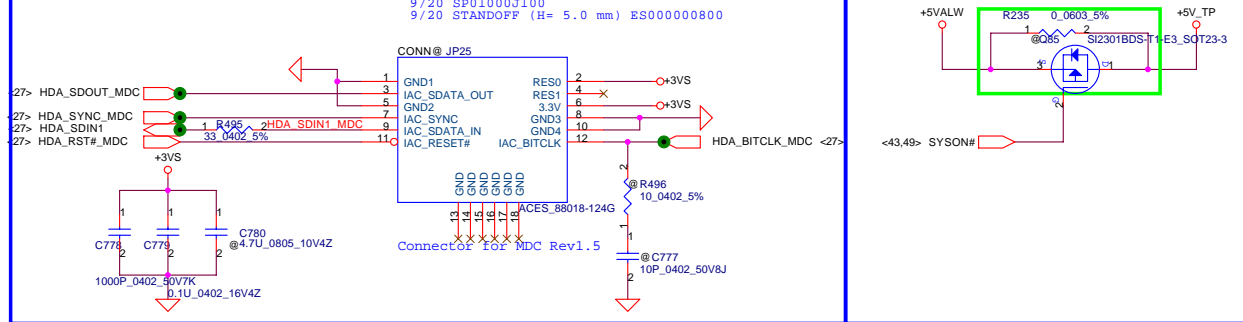
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for debug only

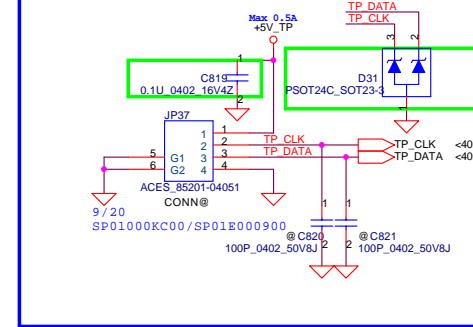
ON/OFF Button Connector(delete) TP ON/OFF



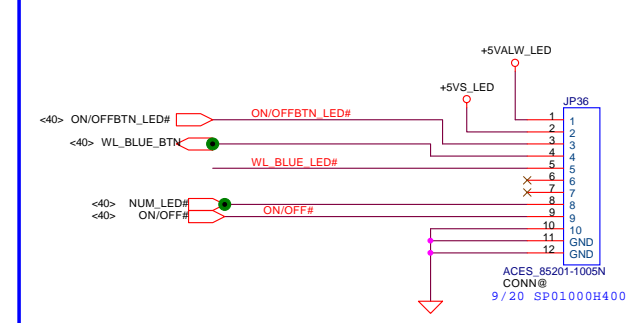
MDC 1.5 Conn.



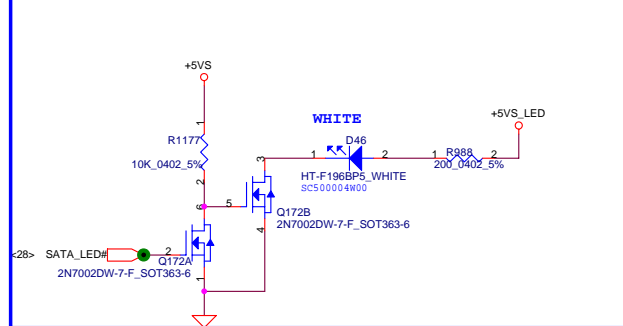
M/B TO TP/B



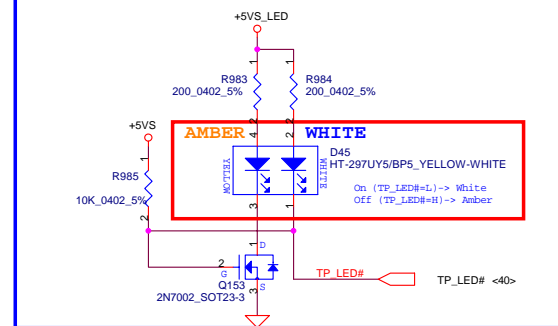
SWITCH BOARD.



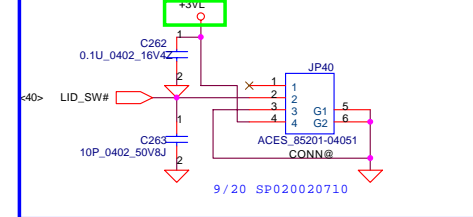
HDD LED



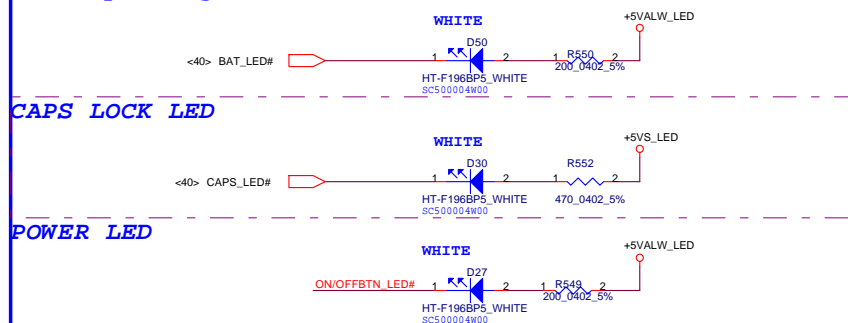
TouchPAD ON/OFF LED



Reed switch BOARD.

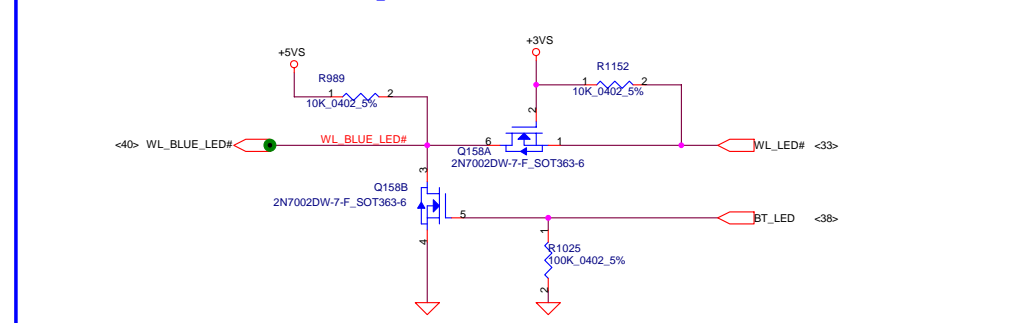


Battery Charge LED



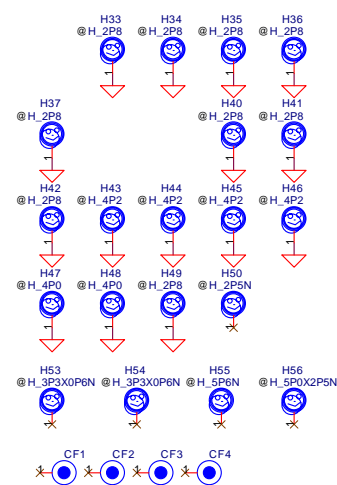
White LED: VF=3V, IF = 10mA, Res = 200 ohm
Amber LED: VF=1.8V, IF = 8mA, Res = 390 ohm

WLAN and BT LED inform pin to KBC



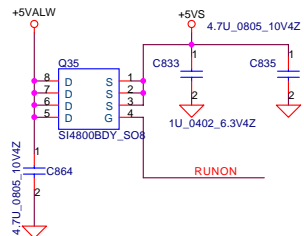
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				Size	Document Number
				Custom	LA-4114P
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H47, H48 -Stand off of MODEM on BOT Side

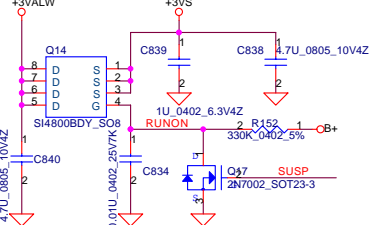


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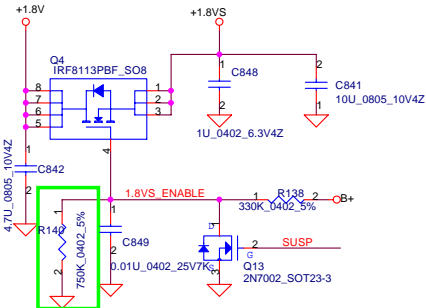
+5VALW TO +5VS



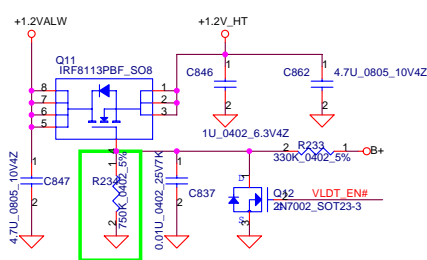
+3VALW TO +3VS



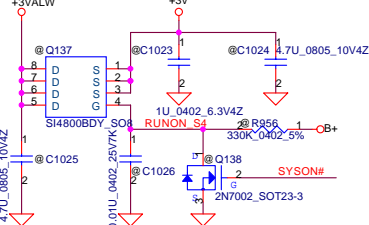
+1.8V TO +1.8VS



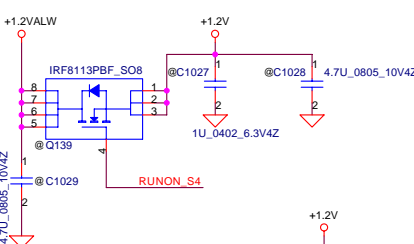
+1.2VALW TO +1.2V_HT



+3VALW TO +3V

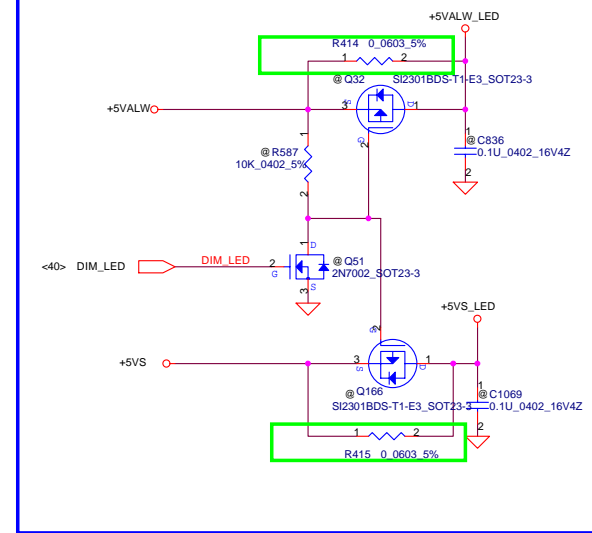


+1.2VALW TO +1.2V

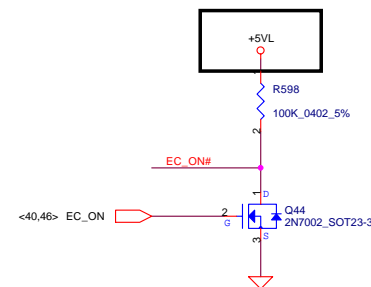
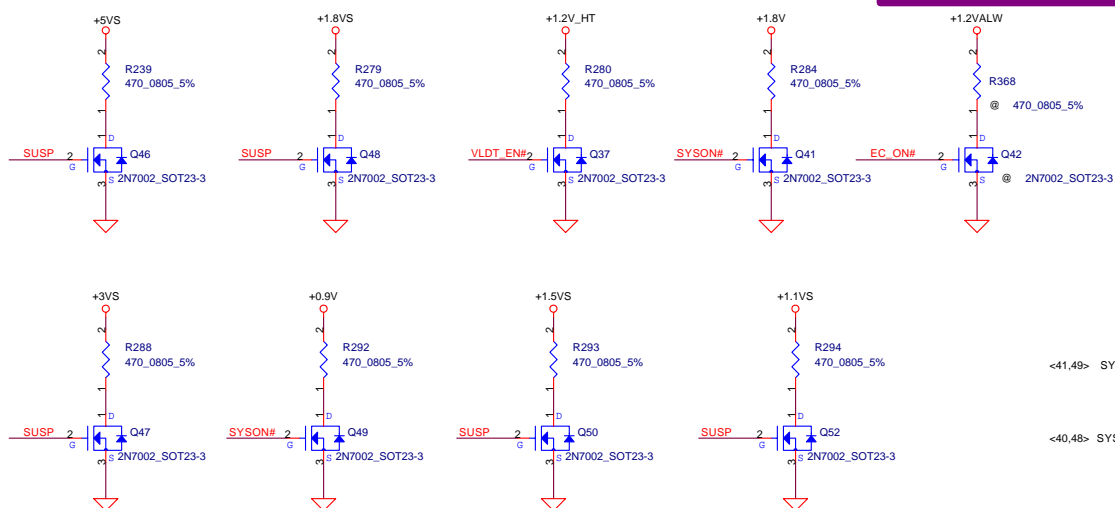


Reserve until SI-1 stage after SB
USB PHY power saving report

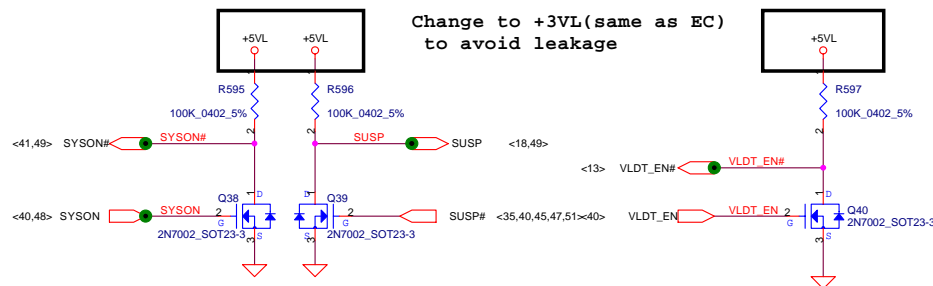
DIM LED



Discharge circuit

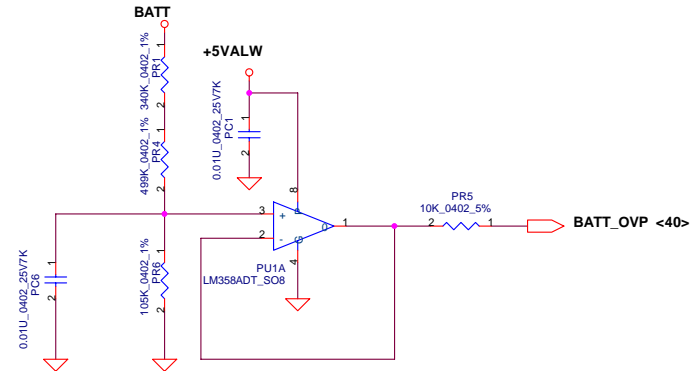
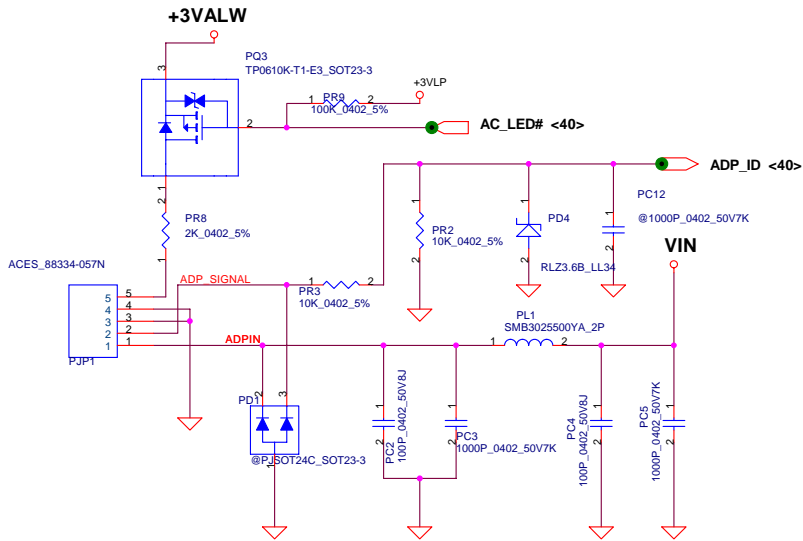


Change to +3VL(same as EC)
to avoid leakage

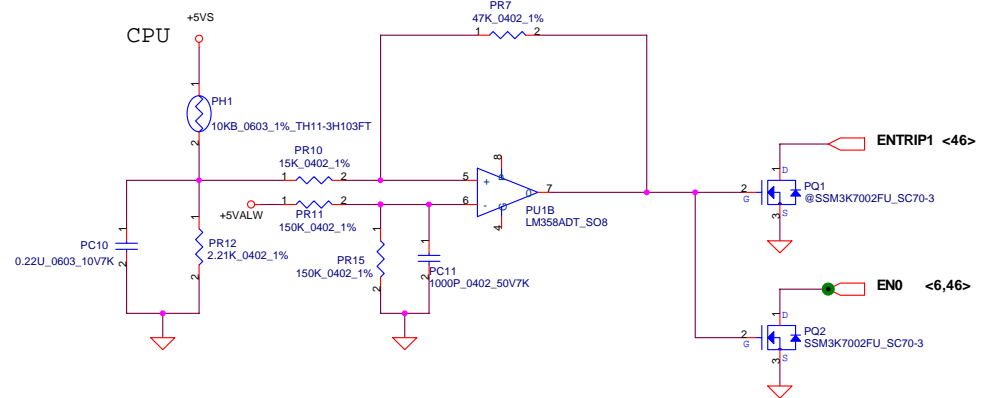
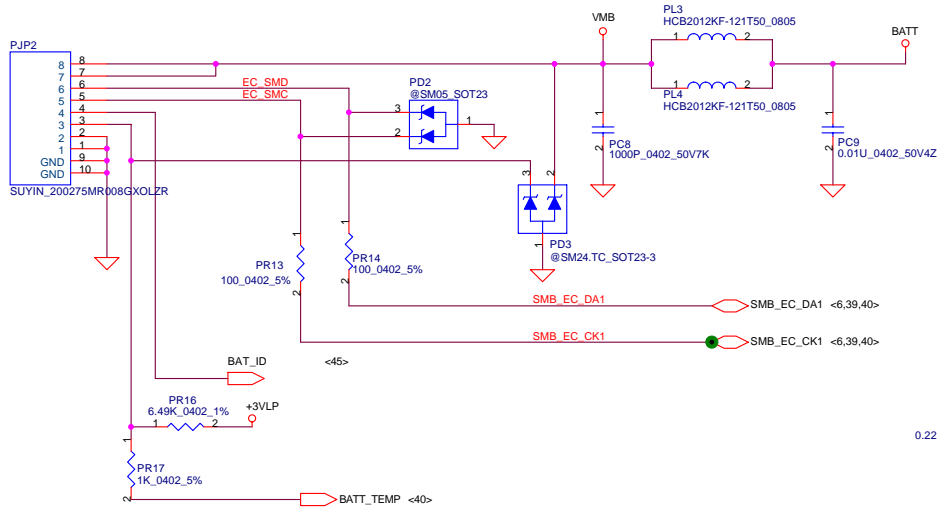


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BATT1
45@ CR2032 RTC BATTERY

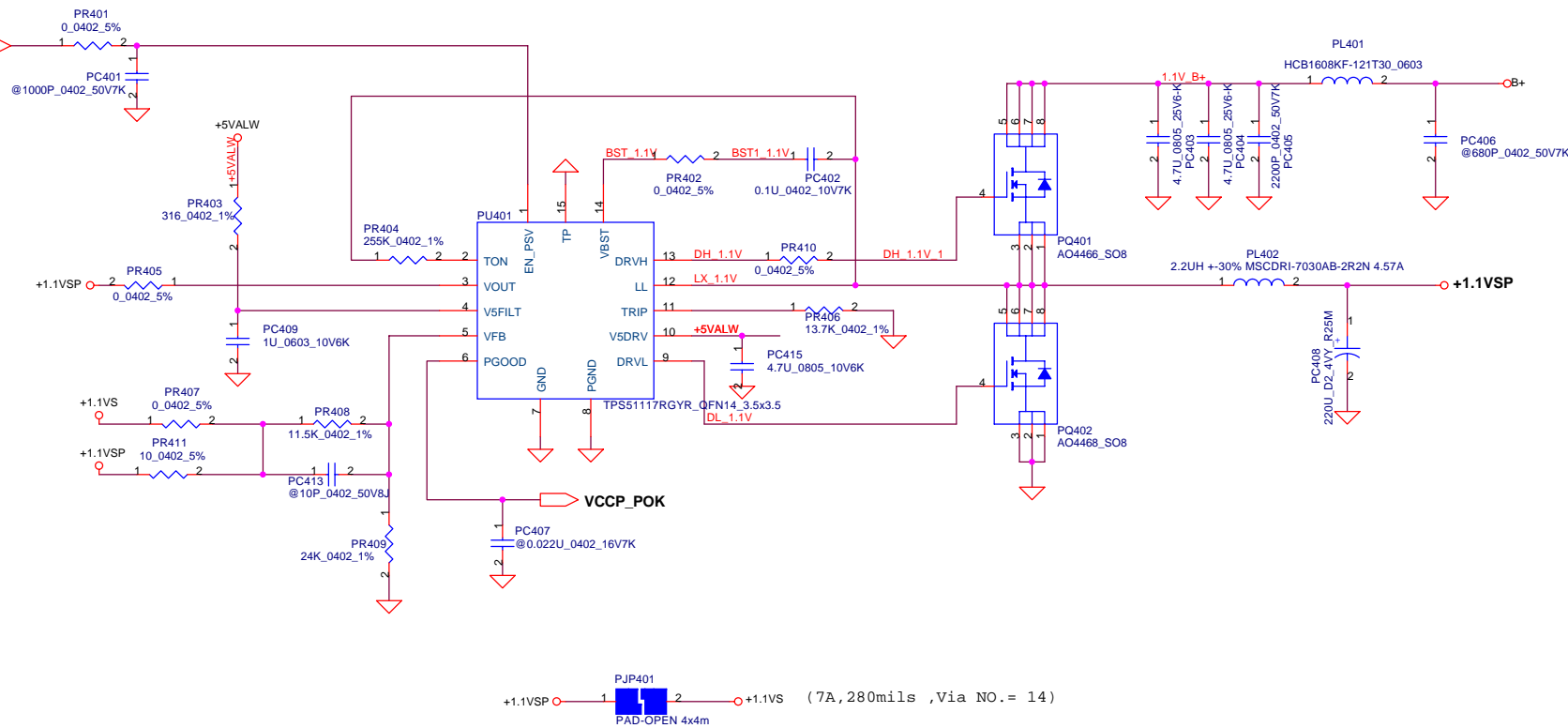


PH1 under CPU bottom side :
CPU thermal protection at 95 +/-3 degree C
Recovery at 47 +/-3 degree C

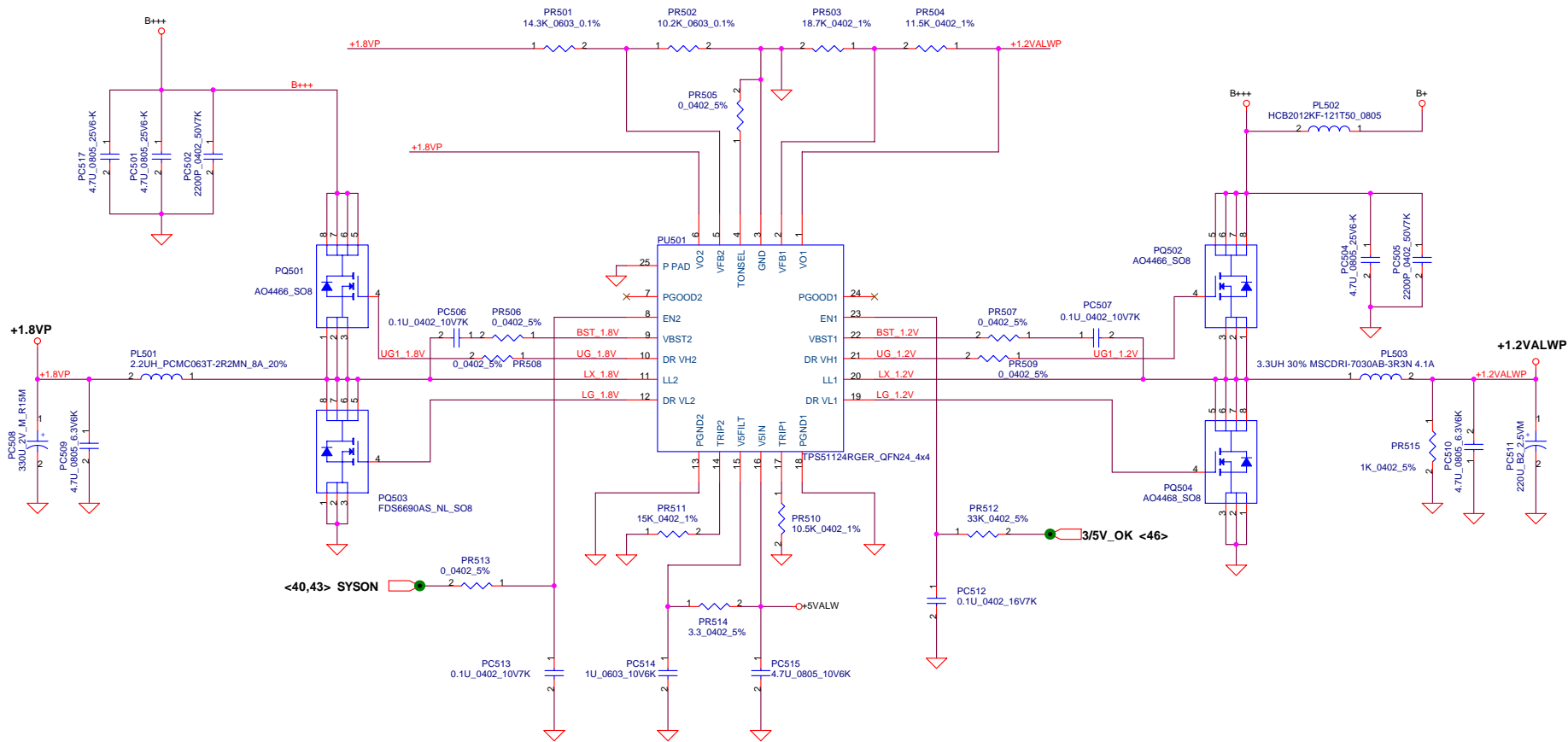


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Deciphered Date				200810/11				LA-4114P			
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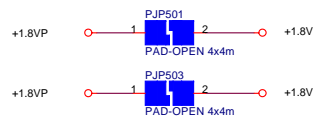
5,40,43,45,51> SUSP#



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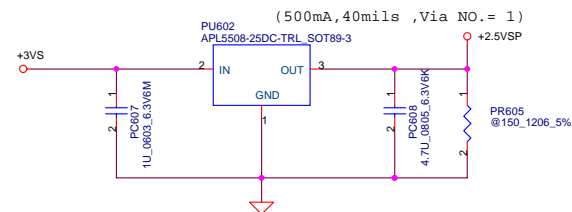
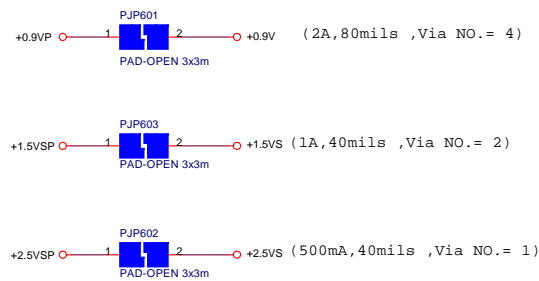
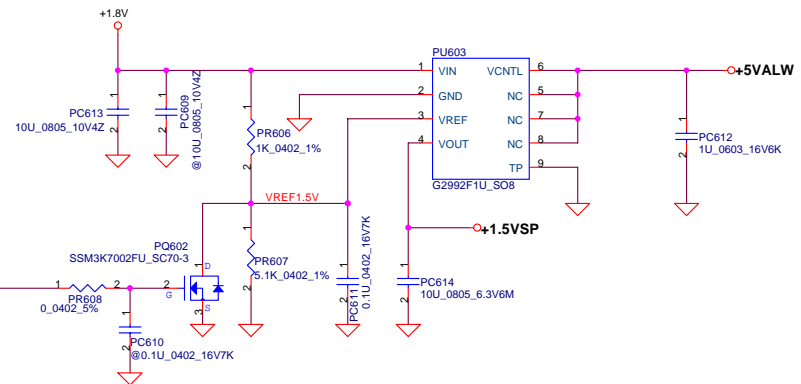
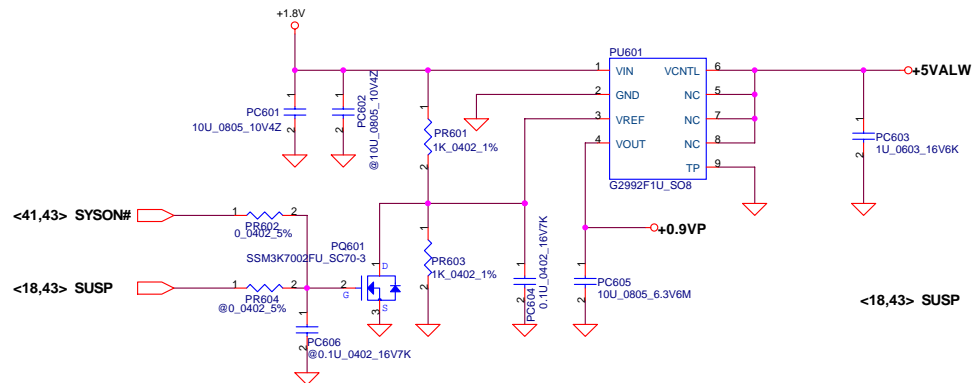
(8A,320mils ,Via NO.=16)



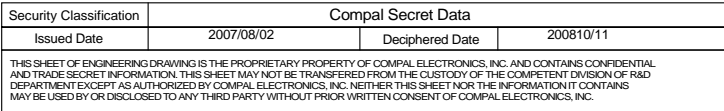
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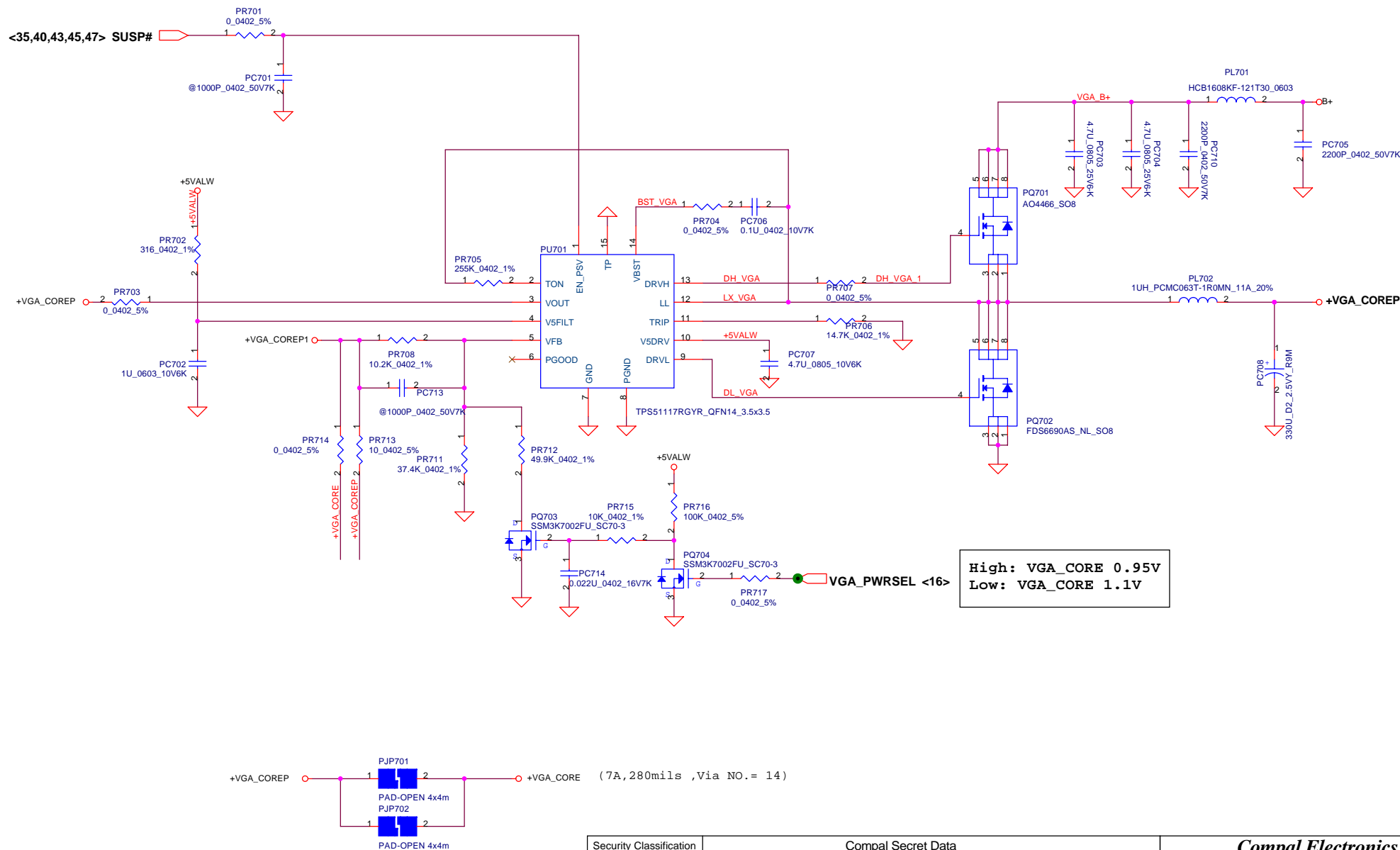


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LA-4112P Rev0.1 -> 0.2 Product Improvement Record (P.I.R.)

BOM change list:

1. Stuff R41(220 Ohm), R26(300 Ohm), R28(300 Ohm). (Page 6)-* AMD recommand.
2. Stuff R1101(10K Ohm). (Page 21)-* Strengthen PCI-E swing to meet PCI-E spec.
3. Un-Stuff R1061,R1062,R1064/Change R214,R211,R217 from 150 -> 75 Ohm/C858,C476,C472 from 22p -> 6pF/Chagne L47,L48,L49 type (Page 16/25)-* Tune CRT(R/G/B) rising & falling skew time to meet SPEC.
4. Change C863 1000p -> 0.047uF. (Page 24)-* For LED Panel power up timing >0.5mSec.
5. Change C643,C652 18p -> 12pF. (Page 26)-* Tune RTC 32K Caps to meet HP SVTP spec.
6. Change R323 11.8K -> 11K Ohm. (Page 27)-* Tune the value to meet USB EE spec.
7. Change R356 10K -> 2.2K Ohm. (Page 30)-* ATI recommand.
8. Change C1040 10U -> 1UF. (Page 36)-* Reduce Power up "BOBO" noise.
9. Change Keyboard connecter type. (Page 40)-* For ME request.
10. Change Reed Switch Board connecter type. (Page 41)-* For ME request.
11. Un-stuff C9. (Page 4)-* Fixed Caps issue noise.
12. Change R371 10K -> 300 Ohm. (Page 10)-* ATI recommand.
13. Un-stuff L2,L4,L6,L9,L7/Stuff C170,C172,C175,C178,C176 0 Ohm. (Page 11)-* ATI RX781 changed recommand.
14. Un-stuff R1054/Stuff C252 0 Ohm. (Page 13)-* ATI RX781 changed recommand.
15. Un-stuff C250,C253. (Page 13)-* Follow 17" AMD circuit change.
16. Change C101,C102 1K->3K Ohm. (Page 14)-* ATI recommand.
17. Un-stuff R1067. (Page 16)-* Follow 17" AMD circuit circuit change.
18. Un-stuff R1155,R1157,R1159. (Page 28)-* Dont need to reserve it for UMA side port buffer strapping.

Circuit change list:

1. Del Q6, Q5 (Page 10)-* Dont need to reserve it.
2. Divide DPA_PDD & DPB_PVDD power.(Page 16)-* ATI recommand.
3. Del Q155 (Page 26)-* Dont need to reserve it.
4. Chagne PCICLK output source to LPCCLK1 output. (Page 26)-* Follow 17" AMD circuit change.
5. Add SSC circuit for AZ bus BIT CLK. (Page 27)-* EMI request.
6. Delete R1002,R1005. (Page 36)-* Dont need to reserve it for line out serial resistor from CODEC to AMP.
7. Modify JP20 speaker signals define. (Page 36)-* DB stage define error fix.
8. Chagne C802 position to +3VALW. (Page 38)-* DB stage +3VAUX_BT leakage fix.
9. Chagne U24 power source from +3VALW -> +3VL. (Page 39)-* Power souce need to be the same power source of SPI ROM.
10. Delete LPC debug port circuit. (Page 39)-* With BIOS discuss and delete it.
11. Add power requesting net "VFIX_EN". (Page 40)-* Power request.
12. Change JP36 pin7 GND -> NC. (Page 41)-* Follow Riply pin define.
13. Swap D45 T/P LED. (Page 41)-* DB Stage LED behavior error fix.
14. Add a signal AC_LED# of EC pin97 & VFIX_EN of EC pin110.. (Page 40)-* Power request.
15. Change AC_IN pull high from +3VALW to +3VL_EC. (Page 40)-* Power request.

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Version Change List (P. I. R. List) for Power Circuit

<i>Item</i>	<i>Page#</i>	<i>Title</i>	<i>Date</i>	<i>Request Owner</i>	<i>Issue Description</i>	<i>Solution Description</i>	<i>Rev.</i>
1	46	3.3VALWP/5VALWP	12/31	Compal	PWR request	Add PU302, control signal changed to ACOFF	
2	51	VGA_COREP	12/31	Compal	PWR request	Connect the PR715 and PC714 to PQ703 pin1	
3	51	VGA_COREP	12/31	Compal	EMI request	Change PC705 to 2220pF	
4	50	CPU_CORE	12/31	Compal	EMI request	Add PC238, PC239, PC240, PC248	
5	50	CPU_CORE	12/31	Compal	Vendor request	Change PR221 and PR231 to 16.6K_ohm Change PR217 and PR233 to 4.02K_ohm Change PR223 to 17.8K_ohm Change PR224 to 100K_ohm	
6	45	Charger	12/31	Compal	EMI request	add PC128	
7	45	Charger	01/04	Compal	PWR request	Change PQ102 to FDS6675BZ	
8	50	CPU_CORE	01/04	Compal	PWR request	Change PQ204, PQ205, PQ207, PQ208 to FDS6676AS Add PQ209 and PQ234 to fix CPU core voltage.	
9	44	DC Connector /CPU_OTP	01/09	Compal	AC LED change to KBC control	AC_LED connect to KBC pin 97	
10	51	VGA_COREP	02/27	Compal	Change VGA low voltage to 0.95V	Change PR712 to 49.9K_ohm and PR711 to 37.4K_ohm	
11	46	3.3VALWP/5VALWP	02/27	Compal	Change OTC shun down pin.	Change OTC shun down pin to PU301 pin13.	
12	50	CPU_CORE	03/03	Compal	EMI request	Add PC249, PC250	
13	45	Charger	03/03	Compal	EMI request	Add PC129	
14	50	CPU_CORE	03/03	Compal	HW request	Add H_PWRGD	
15	44	DC Connector /CPU_OTP	04/02	Compal	AC LED issue	Chaange AC_LED# pull high to +3VLP	
16	50	CPU_CORE	04/24	Compal	acoustic noise	Add PC251	
17	44	DC Connector /CPU_OTP	04/24	Compal	HW CPU thermal protection change to 95 +-3 degree C	Chaange PR12 to 2.21K_ohm	

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Title		Document Number		Rev	
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LA-4112P Rev0.2 -> 0.3 Product Improvement Record (P.I.R.)

Circuit change list:

1. Un-Stuff C18, Q127, Q129, R175, R814, C939 and change SMBus 2 -> SMBus 1. (Page 6)-* Follow 17" AMD circuit change.
2. Add signal H_PWRGD_CPU to option CPU core chip`s PWR OK. (Page 6)-* Follow AMD recommand power up sequence change.
3. Change signal name ENTRIP2 to EN0. (Page 6)-* For power team chagne request.
4. Un-Stuff C54. (Page 7)-* Follow 17" AMD circuit change.
5. AVDD1, AVDD2, AVDDI, AVDDQ, .PLVDD, PLVDD18, VDDLTP18, VDDLTP18_1, VDDLTP18_2 directly conecct to GND.
(Page11)-* For RX781 change recommand.
6. VDD18_MEM1, VDD18_MEM_2 directly conecct to GND. (Page 13)-* For RX781 change recommand.
7. Change Bead L16, L22 to 0 ohm and Delete L20, L21 than use jumper to link the power. (Page 13)-* Follow 17" AMD circuit change.
8. Change R101, R102 3K -> 1K ohm. (Page 14)-* ATI recommand.
9. Add VGA_PWN to Panel. (Page 16/24)-* For panel power saving request.
10. Un-stuff R1101. (Page 21)-* For PCI-E EA request.
11. Add signal CLK_14M_SIO. (Page 22)-* For debug port request.
12. Stuff C447. (Page 23)-* EMI/ESD recommand.
13. Add +5VS power for webcam`s LDO power option. (Page 24)-* Follow 17" AMD circuit change.
14. Change C863 0.047U -> 1000p. (Page 24)-* Fix panel power down waveform bounce.
15. Change Bead L61, L61 to 0 ohm. (Page 29)-* Follow 17" AMD circuit change.
16. Un-stuff R1148, C1271. (Page 32)-* Follow 17" AMD circuit change.
17. Modify JRJ45 layout footprint. (Page 32)-* For DFX request.
18. Add D58 ESD diode. (Page 32)-* EMI/ESD recommand.
19. Stuff R1043, Un-stuff R1042 (Page 33)-* Follow 17" AMD circuit change.
20. Add R399, R400 and un-stuff R122, R1051, Q53.(Page 34)-* Follow project common design.
21. Add C259, C260, C261 and stuff C746, C747,C748 and change C760, C761, C762, C763 100p -> 330p. (Page 35/36)-* EMI/ESD recommand.
22. Signal INTMIC_DET directly connect to AGND and Delete Q160, Q151, R951. (Page 35/36)-* OPP dont need the detect circuit.
23. Add C258. (Page 38)-* EMI/ESD recommand.
24. ME change JP32 and change Q24`s power +3VALW -> +3VS. (Page 38)-* Follow 17" AMD circuit change.
25. Add LPC debug port. (Page 39)-* For debug request.
26. Add D57, R397. (Page 40)-* Fix AC-IN chip power rail different issue.
27. Delete Q34, R645. (Page 41)-* Follow 17" AMD circuit change.
28. Add C262, C263. (Page 41)-* For Small/B design change.
29. Chagne C1175 type B2 ->Y. (Page 18)-* For fixed ME issue.
30. Add C264. (Page 22)-* For IDT request.
31. Add L85, L86, L87, L88. (Page 22)-* For EMI/ESD recommand.

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LA-4112P Rev0.3 -> 1.0 Product Improvement Record (P.I.R.)

Circuit change list:

- 1. Reserve R59, R60, R61. (Page 6)-* AMD suggest to reserve the pull high/down resistor of these test pin.
- 2. Add C477 0.1UF. (Page 23)-* For EMI recommand.
- 3. Change R906 from 0 ohm to 1k ohm. (Page 36)-* For reduce MIC background noise issue.
- 4. Change SMB DA1/CK1 pull high power rail from +3VALW to +3VL. (Page 40)-* EC recommand & follow Riply change list.
- 5. Add C819 0.1UF & D31 ESD diode. (Page 41)-* For EMI recommand.
- 6. Add R414 & R415 0 ohm. (Page 43)-* no support DIM function.
- 8. Add R140 & R234 750k ohm. (Page 43)-* Solve Rds on issue.

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